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Powerhouse.

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Telephone (213) 973-4545

RCA Trunk Terminator Module

RCA CCT-3 Series Telex Switching System
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Chicken about progress

In this age of super small components and sophisticated electronics, one industry is still relying on old-fashioned electromechanical gadgetry.

Most of those fried chickens you purchase at the hundreds of fast-food chicken outlets around the country are so crispy and brown and thoroughly delicious because of an old-fashioned synchronous motor driven reset timer manufactured by Gulf & Western's Eagle Signal Div., Davenport, Iowa. The frying is done under pressure in large quantities and as fast as possible, says Joseph A. Carlin, marketing manager for industrial controls. "A half a minute or even several seconds can make the difference between a good batch and a ruined batch," he notes. To duplicate the timing control, electronically, Carlin says, would, of course, be possible—but at two to three times the price of the electromechanical units. And then it wouldn't necessarily be an improvement.

Power Hybrids sets the record straight

We appreciate the coverage given to Power Hybrids, Inc., in the Sept. 1 issue and thought the survey was complete and informative ("Rf and Microwave Semis Rising in Power and Declining in Noise," ED No. 23, p. 94). For the record:

The photo of the TAC-250 circuit was supplied courtesy of Elliot Ressler of the Naval Air Development Center, Warminster, PA.

In addition we detected an error in the caption under the photo. The frequency range should have been 960 to 1215 MHz instead of 960 to 121.5 MHz, but I'm sure the readers instinctively knew the correct range.

Wayne E. Schaub
Vice President Marketing
Power Hybrids Inc.
1742 Crenshaw Blvd.
Torrence, CA 90501

Exact's generator costs less than it seems

We were very happy to see the notice of the Exact Model 7059 Pulse/Sweep/Function Generator on p. 93 of the Aug. 16 issue. May we point out, however, that in your copy you indicated a price of $1895 for this instrument. This is $1000 higher than the actual price of the Model 7059.

Joe Foster
U.S. Sales Manager
Exact Electronics Inc.
455 S.E. Second Ave.
Hillsboro, OR 97123

Misplaced captions

"The focus circuit needs a bit of work."


Electronic Design welcomes the opinions of its readers on the issues raised in the magazine's editorial columns. Address letters to Managing Editor, Electronic Design, 50 Essex St., Rochelle Park, N.J. 07662. Try to keep letters under 200 words. Letters must be signed. Names will be withheld on request.
DELCO'S NEW FAS HIGH-GAIN TRANSIS

MAJOR PARAMETER LIMITS

<table>
<thead>
<tr>
<th>TYPE</th>
<th>$h_{FE}$</th>
<th>$V_{CEO}$</th>
<th>$V_{CE}$ (sat)</th>
<th>$t_f$ (typical)</th>
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<td>700V</td>
<td>300V</td>
<td>1.4V</td>
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</tbody>
</table>

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And, of course, these high-energy silicon power transistors come in Delco's solid copper TO-3 packages to ensure low thermal resistance.

The accompanying curves, charts and circuits tell part of the story. Prices, applications literature and electrical data from your nearest Delco sales office or Delco distributor can supply another part.

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<td>0.5V @ 300A</td>
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To keep system costs low, the 2104 operates on standard -5, +5 and +12V power supplies, and TTL I/O levels. All inputs including clock

<table>
<thead>
<tr>
<th>INTEL'S STANDARD 4K RAM FAMILY</th>
<th>Part Number</th>
<th>Pins</th>
<th>Max Access Time (ns), 0-70°C</th>
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inputs are fully TTL compatible.

Overall system advantages of the 2104 are detailed in a new application brief, "Which Way for 4K... 16, 18, or 22 Pin?" It explains why the 16-pin 2104 is best for very compact systems such as minicomputers, microcomputers, terminals, business equipment, scientific calculators and anywhere high density is needed.

Moreover, we show how the 16-pin standard is compatible with the next generation of even higher density memories. The application brief also tells why the 2107B's simple, straightforward 22-pin design has become an industry standard for computer main memories and many other applications.

Now the industry has two standard configurations—16 pins with multiplexed addresses and 22 pins with parallel addresses. Whatever way you go, you'll find Intel ready to support both in volume production. For delivery of the 2104 or 2107B contact our franchised distributors: Almac/Stroum, Component Specialties, Cramer, Elmar, Hamilton/Avnet, Industrial Components, Liberty, Pioneer, Sheridan or L.A. Varah.

For your copy of "Which Way for 4K..." or data sheets on any of our 4K RAMs write: Intel Corporation, 3065 Bowers Avenue, Santa Clara, California 95051.
Using solid-state technology to replace bulky tube-type equipment, ENI's broadband amplifiers are tomorrow ideas available today. ENI's Class A power amplifiers already cover the frequency spectrum of 10 kHz to 1 GHz, with power outputs ranging from 300 milliwatts to over 4000 watts. And we're still climbing. Driven by any signal generator, frequency synthesizer or sweeper, ENI's compact portable amplifiers are completely broadband and untuned. Amplifying inputs of AM, FM, SSB, TV and pulse modulations with minimum distortion, these rugged units are versatile power sources for general laboratory work, RFI/EMI testing, signal distribution, RF transmission, laser modulation, data transmission, NMR, ultrasonics and more. Designed to be unconditionally stable and failsafe (impervious to severe load conditions including open or short circuit loads), ENI power amplifiers will deliver their rated power to any load, regardless of match.

Microcomputers giving rise to new medical instruments

A new class of mass-producible, intelligent medical diagnostic instrumentation incorporating microcomputers will be developed at the Massachusetts Institute of Technology to overcome the limitations of computer-based medical research systems now used.

Expected advantages of the new approach include the following:

- Substantially lower cost.
- Much smaller instrument sizes, suitable for use in a clinical setting rather than only in a research laboratory.
- Simplified operation, with the microprocessor taking over the monitoring of medical diagnostic tests and routines.
- Data processing in real time and with simplified presentation, so that highly skilled medical researchers or computer personnel are not needed to interpret the results.

The work at MIT will be performed in the Core Microprocessor Engineering Laboratory as part of a new program administered by the Biomedical Engineering Center for Clinical Instrumentation. The center is being established by the joint Harvard-MIT Program in Health Sciences and Technology with the help of a Federal grant of $1,016,439.

The center's first research projects will be the design, development and testing of four basic types of instruments: (1) A computerized monitor for detection of irregular heartbeats; (2) Equipment and techniques for the diagnosis of causes of dizziness and disequilibrium; (3) Instrumentation for collecting and processing respiratory-function data for the study of dynamic events found in asthma victims; and (4) A probe for the measurement of blood flow through tissues to monitor patients during surgery.

The center will be under the direction of Roger G. Mark, M.D., Ph.D., associate professor of electrical engineering in the MIT Dept. of Electrical Engineering and Computer Science. He also is assistant professor of medicine at the Harvard Medical School and director of the Biomedical Engineering Dept. at Beth Israel Hospital in Boston.

Dr. Mark will direct the work of developing a wearable, computerized device that can monitor, identify and evaluate heartbeat irregularities in ambulatory patients. If the heart indicates failure, the device will give a warning.

Dr. Laurence R. Young, professor of aeronautics and astronautics at MIT, heads the project on instrumentation for diagnosing dizziness and vestibular instability. He sums up his approach, which is representative of the over-all program this way:

"The problem is that current methods of diagnosis are clumsy, difficult for the doctor, uncomfortable for the patient, and require specialized equipment that is usually not available in a clinic.

"Our objective is to take a number of test conditions that are used to evaluate dizziness—this requires measurement and analysis of nystagmus, which is an arrhythmic movement of the eyes when a subject is rotated or if his balance is upset—and put the instrumentation into a single, usable package for the clinician.

"The next step will be to take computer programs for analysis of this nystagmus and reduce them to the level of hard-wired programs on a microprocessor."

The advantages of reducing this system to a µP-based instrument are lower cost and smaller size. In addition, Young says, you'll have a dedicated machine that a medical technician can use and that does not require a knowledge of software and programming.

Hand-held control unit to monitor artillery

A new hand-held control system that will automatically monitor artillery and ultimately provide correction data for a target is under development at the Army's Picatinny Arsenal in Dover, NJ.

The new device, still in the development stage, will look like a hand-held calculator and will contain a radio to receive firing data transmitted by transducers on a piece of artillery.

According to Dan Ramer, an engineer at the arsenal, the prototype is being built with a MOS Technology two-chip calculator set. The final product, however, will probably use a CMOS microprocessor, he says. The unit, Ramer explains, will use Schottky logic to provide a 100-MHz capability, while all the rest of the circuitry will be CMOS.

To achieve maximum battery life, circuitry that is not in use is automatically disconnected. The unit contains a ROM that holds 256 program steps. This eliminates the need for any sort of programming by the user. Specific calculated data as to shell velocity and acceleration, recoil velocity of the artillery and orientation with respect to gravity are read out on a digital display when the appropriate button is pressed.

The initial unit will only read out these individual parameters, but Ramer says there is no reason why a little extra programming can't be done to have the device read out corrected coordinates for a target.

The transducers for this system, Ramer reports, will be mounted in a removable collar that can be quickly attached to any piece of artillery. The telemetry equipment will be self-powered.

Ramer notes that either the heat, pressure or physical movement of the weapon when fired will be used to generate electricity to power the transducers and transmitter. Final units should go into production in about a year, he says.
Laser-TV bomb sight likely to raise accuracy

Day and night bombing accuracy by Marine Corps aircraft is expected to improve significantly with a new angular-rate bombing system being built at Hughes Aircraft, Canoga Park, CA. Unlike most current bombing systems, neither measurement of range to the target nor inertial quality platform inputs are required.

The bombing unit uses a combination laser and TV system that automatically acquires the ground target and immediately begins to track on the aircraft’s first pass over the target.

According to Richard Furtaw, program manager at Hughes: “The system is basically a simple angular-rate system. The tracker, after locking on a target, provides the aircraft-to-target line-of-sight angle and angle rate to the weapon-delivery computer. This information, combined with the true airspeed and altitude, is processed by the computer yielding the weapon delivery solution.”

Target position, weapon release and azimuth-steering information are displayed to the pilot on a head-up display.

Furtaw notes that the dual-mode laser-TV tracker is the heart of the system. A television tracker shares a common optical system with a laser spot tracker. A dichroic filter behind the optics separates the laser energy from the visible light for sensing by a four-quadrant laser detector.

A portable radar set to survey battlefields

A hand-held battlefield surveillance radar being developed for the Marine Corps to detect both personnel and vehicles is so light (10 pounds) and inexpensive (a tenth the cost of existing units) that it’s also being considered for other military and civilian applications.

Under development for about four years by the Naval Electronics Laboratory Center, San Diego, the X-band, solid-state transceiver was developed by Rockwell International’s Autonetics Div. and the antenna by the company’s Missile Systems Div. both in Anaheim.

The reason for the cost reduction, the Navy says, is that it does not require the diode or ferrite phase shifter for each array element that existing radars do.

The unit is designed to use an electronic scan antenna with 26 elements and two ferrite analog circuits to provide ±45-degree coverage. The antenna provides a six-by-six degree beamwidth at 9 GHz, with sidelobes down to 18 to 20 dB. It will weigh about two pounds and will have a beam control power of about 0.5 W.

The X-band transmitter signal is derived from an S-band source, quadrupled and biphase-coded. The resulting signal is applied to an Impatt diode.

The main purpose of using this technique, Navy Laboratory engineers say, is to achieve a more efficient power source and to increase the power output. They predict a transmitter efficiency of 8%—an increase of an order of magnitude over present battlefield surveillance radars. The average power, they estimate, will be 2.5 W, which represents a 20-dB gain over that of conventional units.

The primary advantages of using fiber optics for remote control capability are low weight, RF/EMI immunity, and wide bandwidth capability. The predicted weight for 50 m of a four-channel fiber optics cable is about one pound.

Hitachi cites advance in optical IC work

Continuous-wave, room-temperature operation of a new distributed feedback semiconductor laser—reported by Hitachi in Japan—promises to bring a practical optical IC system a step closer.

Room-temperature operation eliminates the need for cooling and simplifies substantially the interface between the distributed feedback gallium-arsenide-phosphide devices and OIC elements. Also, it is possible to integrate several of these distributed feedback lasers—each with a different wavelength—in one element. As a result, a number of independently modulated laser beams can be easily generated and sent through a single optical fiber.

With the distributed feedback device, the optical resolution necessary for lasing action is obtained by use of an internal grating structure instead of the mirror surfaces found in regular semiconductor lasers.

This grating structure, according to M. Nakamura, K. Aiki and J. Umeda, researchers at Hitachi’s Central Research Laboratory in Tokyo, produces radiation of substantially purer spectral quality and better modal control than that of the conventional lasers.

Data General builds its own MOS chip

Overshadowing Data General’s recent introduction of its Nova 3 OEM minicomputer family was the announcement that the machine’s memory module would contain a dynamic n-channel, 4096-bit MOS RAM chip manufactured by Data General in Sunnyvale, CA.

It’s believed to be the first time a small computer firm has extended in-house manufacture of computer parts down to the level of complex MOS devices.

“The use of in-house manufactured chips,” says Donald McDougall, Nova 3 marketing manager, “allowed the chip to be designed with close interaction between our semiconductor specialists and Nova 3 system engineers. This resulted in the best overall RAM/memory design that could be developed for these computers.”

An alternate memory board will be available using MOS parts supplied by Texas Instruments.

The four-slot Nova 3/4 and 12-slot Nova 3/12 are available with core memory in 8-k and 16-k-word increments, or MOS semiconductor memory in 4-k, 8-k or 16-k-word increments.

The new computers feature main memory expansion up to 128-k words, an extended data channel and 16-level priority interrupt structure.

Memory cycle speeds are 700 ns for MOS memory, 800 ns for 8-k word core and 1000 ns for 16-k core.

McDougall notes that at the low end of the OEM market, the Nova 3 challenges microcomputers in a number of applications.
### Double Balanced Mixers

**.05 MHz to 3 GHz (+17 dBm LO)**

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  - **$19.95**

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<th>Conversion loss (dB)</th>
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</table>

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**INFORMATION RETRIEVAL NUMBER 15**
Good news from Hughes for circuit designers bogged down in SSI/MSI:

Now you can get these popular high-density CMOS/LSI circuits off the shelf.

4-Decade Counters
Three CMOS units to choose from:
- 2 MHz, up/down, BCD outputs (HCTR4010)
- 1 MHz, BCD outputs, 16-pin package (HCTR6010)
- 5 MHz, presettable, 7-segment outputs (HCTR0154)

CMOS Decade Counter/Latch/Decoder/Driver
(HCTR0200)
- Up/down, 2 MHz, 5V operation
- 7-segment output compatible with LED and LCD
- Units may be cascaded

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(HPLA0174)
- 1 MHz with 5V supply
- 19 inputs, 16 outputs
- 12 on-chip DFFs, 70 product terms

CMOS LED/LCD Watch Chips
- 32 KHz crystal oscillator
- Hours, minutes, seconds, date
- Low power, AM indicator
- De-bounced set inputs

Our business is making advanced MOS/LSI devices. Mostly they’re custom circuits, but we also produce designs that have widespread application as standard parts.

We’re now offering some of our standard devices to circuit designers still burdened with SSI and MSI circuits—to save space, power, cost and time, and a lot of headaches. Look over these proved-and-packaged circuits and let us know which ones fit your particular needs. We’ll send you specs, prices and delivery information.

Need custom MOS designs? We’ve developed a systematic design procedure for handling any custom MOS project, from simple logic to large scale systems. And we have the comprehensive manufacturing and automated testing facilities to complete the production cycle. (Our new brochure offered here tells how it works.) Use our extensive experience in MOS/LSI circuits to meet unusual requirements such as wide supply variations, high speed, ultra low power, differential amplifier input, RC oscillator and crystal oscillator.

For more information, use the handy reader service number shown under each product group, or contact Hughes Microelectronic Products Division, 500 Superior Avenue, Newport Beach, California 92663. (714) 548-0671, Ext. 346.
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If you’ve never looked at Malco, look now. Malco offers a complete line of rectangulars including some of the smallest high-density connectors available. . . . to help meet your tightest packaging requirements. Like our MCDM 1 Micromate.** Only Malco gives you a metal shell connector like this one with as many as 184 straight-through connections, centers as small as 0.050" and very little weight.

Whether you’re designing with conventional wire, coax, flat cable or ribbon-cable, Malco has the rectangulars you can plug into your circuitry—all with the Twist/Con™ high reliability contact system. And if you ever need help getting out of a tight squeeze, you can depend on Malco for a custom engineered rescue operation. Malco—the only contact you need for all your connectors. Write today: 12 Progress Drive, Montgomeryville, Pennsylvania 18936 or call our South Pasadena facility (213) 682-3351 for price and delivery.

Twist/Con™—22/24 pins and sockets. In the Twist/Con system, the male contact is constructed of seven strands of spring copper alloy wire wound helically around an inner core of three copper alloy strands. This creates a breathing helical spring so that contact is made at many points around the periphery of the pin bundle instead of a few discrete points as in conventional design.

- Material: Copper Alloy
- Plating: .000050" Gold over Copper Flash per MIL-G-45204, Type II
- Rating: 5 amps for 22 pins, 3 amps for 24 pins.
- Contact Resistance: .008 ohms max.

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INFORMATION RETRIEVAL NUMBER 17
Instant breadboarding
Takes the tedium from microcomputer systems design

“Donkey Work” in microcomputer systems development seems endless. It doesn’t have to be! With Motorola’s M6800 Family and an EXORciser*, that wasteful tedium is no longer necessary.

EXORciser configuration as a prototype of a unique M6800 system is fast and simple using standard production board options. That’s instant breadboarding. It’s in the M6800 tradition of simplifying and accelerating the design job. But, instant breadboarding is only one of the key functions of this triple-threat design development tool.

The EXORciser also is used to edit and assemble source programs, and its very name is derived from the functions of debugging, exorcising, and evaluating M6800 system designs in real-time.

It’s both the complete system emulation tool and the debug system, too. Two systems in one. Emulation of the user system within the EXORciser chassis is achieved with the use of optional memory and I/O modules. With an external system, connect its bus as an extension of the EXORciser bus, and timeshare the EXORciser’s MPU.

The basic machine consists of MPU, Debug and Baud Rate Modules, with chassis and power supply. Flexibility is enhanced by options for altering memory and I/O, the 2K Static RAM, 8K Dynamic RAM, Input/Output and ACIA modules. EXORciser options also include extender and wirewrap modules, flat-ribbon interconnect cable, and battery backup.

There’s a full range of M6800 support software and hardware


Custom and host computer software are available, and so is a full complement of M6800 Resident Software.

Evaluation Modules. Certainly the EXORciser is the ultimate M6800 system development tool, but many designers may prefer to first evaluate the operating characteristics of the various M6800 Family devices with one of several evaluation module options. These include a bare board, a completely assembled and tested module, and the same version with an 8K Dynamic RAM module plus resident software.

Support Peripherals. Other systems development tools supplement EXORciser capabilities. The EXORDisk* floppy disk unit and EXORTape* high speed tape reader are available. More items are being added.

For complete story on Motorola’s M6800 support hardware and software, use the reader service number or write to Motorola Semiconductor Products Inc., P.O. Box 20912, Phoenix, AZ 85036. Any Motorola sales office or authorized Motorola distributor can handle your questions and your order.

*Trademarks of Motorola Inc.
As hybrid circuit manufacturers reach for more complexity in their designs, impressive advances in individual chip components are turning their ideas into reality.

Capacitors, inductors and resistors are getting smaller and smaller. Component costs also are dropping. And—how lucky can you get?—ranges are being extended.

Chip capacitors are now available with values from 1 pF to well over 200 µF in chip sizes from 30 mils square by 5 mils thick to 250 mils square by 100 mils thick.

Inductors are being offered with values from 1 nH to over 10 mH in both fixed and variable types, while sizes start at 50 × 80 × 25 mils and increase to over 250 × 250 × 200 mils.

Chip resistors and resistor networks come with values from 1 Ω to 10¹² Ω, while tracking capabilities are to within 1 ppm/°C.

There are now three major families of chip capacitors: monolithic ceramic, tantalum and MOS. Inductors can be broken down into two families: deposited and wound. And for resistors, there are thin-film and thick-film types.

Within each of these areas, manufacturers are developing new ways to lower costs, extend the value range and shrink the size. For instance:

- New materials and processes for monolithic ceramics promise to cut costs up to 50% by eliminating the use of precious metals and replacing them with base metals.
- Thinner dielectrics will permit a fourfold increase of capacitance per unit volume.

Dave Bursky
Associate Editor

Thin-film resistor networks, deposited on either silicon chips or ceramics, made by Analog Devices are coming down in cost when used in high volumes.

Ceramic chip capacitors in various sizes, including these from USCC/Centralab, range in value from 0.1pF to over 200 µF. Ratings are from 4 to 200 V.
Better packages for tantalum capacitors promise to eliminate reliability problems of the T-bar construction.

New mounting methods are permitting low-cost thermal compression bonding instead of reflow soldering or conductive epoxy.

More use of machine operations is expected to cut the cost of chip inductors by up to 75%.

Increasing use of laser trimming in thin-film networks is making possible tight-tolerance applications.

Automated processing is expected to cut the cost of thin films by over 50% in the next few years.

Base-metal cuts ceramic costs

Ceramic chip manufacturers have had problems with the rising cost of precious metals. USCC/Centralab, though, has done something about it. The company has developed monolithic ceramic capacitors that use a base metal compound for the electrodes. This makes them 30 to 50% cheaper than ceramic types that use precious metals. In 5000-piece lots for a 0.1-μF capacitor, the new capacitors sell for less than 10 cents each.

USCC/Centralab, Union Carbide, AVX, Sprague, Centre Engineering and other companies predict that new and thinner dielectric materials will permit higher capacitance per unit volume. More capacitance without an increase in package size will be a reality within the next year.

Ceramic chip manufacturers offer various termination styles designed for reflow soldering or conductive epoxy attach techniques. However, AVX claims to have found a better way with its Planar series of foil-tab leaded chips, intended for low-cost thermal compression bonding. Prices start at $3 to $10 in single quantities, and the values range from 1 pF to 1 μF. Four different dielectrics are available, along with 12 chip sizes.

Monolithic ceramic capacitors are the most widely used chip family, but within the family many different dielectric types are available. Three of the most common are the NPO, X7R and Z5U. The temperature characteristics and prices of monolithic capacitors with these materials differ widely.

The NPOs are ideal for high-stability circuits, have tempco of about ±30 ppm/°C and are typically available with values from 5 pF to 0.02 μF. X7Rs are good for bypassing applications, have tempco of about 50 ppm/°C and can range in value up to about 0.1 μF. The Z5Us offer the widest range of applications, have tempco of about 100 ppm/°C and are available with values of over 2 μF.

The lower-cost chips are the—such as the Z5U—have properties that are similar to those of tantalum capacitors, although the values are limited to about 2 or 3 μF when the K is more than 1000.

Medium-K dielectrics, such as the X7R formulations (K between 100 and 1000) can equal the performance of Mylar and polycarbonate types. The low-K types, like NPOs (K less than 100), have characteristics similar to those of mica and polystyrene capacitors.

You need a scorecard

Telling different valued chips apart can be troublesome, since many values are available in the same package size. Marking the values on the tiny chips is an art. Some companies have even resorted to laser marking to get the values ingrained permanently. Coding is done either by letters, dots, numbers or combinations thereof.

If you don't know the value you need, several companies offer adjustable chip capacitors that let you add or subtract capacitance within a limited range. Vitramon has its Vee-Cal series of chip capacitors with an NPO dielectric that permits up to 12 incremental adjustments. Base values start at 10 pF and go up to 680 pF in 24 models. Adjustment increments vary from 1 pF for the small-value units to 20 pF for the larger values.

Each of the Vitramon chips has adjustment contacts on two sides—one set for the coarse adjustment and the other for the fine. A maximum of six adjustments can be made on each side. All that's needed to adjust the value is a lead pencil and an eraser. The chip sizes are all identical—0.18 × 0.05 × 0.05 in.

Semtech offers a different method with its SC6000 series. The company will sell you slabs of monolithic capacitors made from barium titanate ceramic. The slabs are about 1.8 × 1.8 in., which you can then cut to the value you need with a diamond saw. Result: instant custom capacitors.

The Semtech slabs have capacitance values up to 23,000 pF and are available in voltage ratings of 2 to 20 kV. Slabs are also available with custom voltage ratings of up to 70 kV. Prices start at 66 cents.
and rise to $10 a slab in 1 to 10 quantities.

**Tantalums pack it in**

To get even more capacitance in a small space, users now have tantalum-based capacitors. These can have values from about 0.1 \( \mu F \) to over 200 \( \mu F \), while taking up no more room than the large ceramic chips. Typical sizes range from 50 \( \times \) 100 \( \times \) 50 mils up to 150 \( \times \) 285 \( \times \) 110 mils.

There are, though, several different termination variations for the chips. For instance, National Components Industries offers end-terminated Blue-Chips, with wide area mounting terminals that are similar to those on ceramic chips. Other companies, like Union Carbide and Corning, have the T-bar structure, which uses the chip itself for one terminal and an lead shaped like a T for the other.

The T-bar has a tendency to break, however, if the chips are not handled with extreme care, says Robert Gress, tantalum capacitor product manager for Corning.

Prices for the tantalum capacitors start at about 20 cents for a low value and increase to about $2 and more for larger values or higher voltage ratings. Ray Irion, marketing manager for Union Carbide, says that tantalum chips cost less than ceramics with the same value. And they provide the user with a more stable temperature characteristic, he notes.

**Capacitors get transistorized**

Metal-oxide semiconductor technology is being used for capacitors of low value. But so far only a handful of companies—Texas Instruments, Dionics and Micro Networks, among them—are offering MOS chip capacitors. The values range from fractions of a picofarad to about 150 pF.

The advantages of these chips include their low height from the circuit substrate—typical thicknesses are only 5 mils against the 20-to-50-mil thicknesses of ceramic types.

Larger values than the 150-pF upper limit are possible, note George Seaton, marketing manager for Dionics, and Robert Jay, president of Micro Networks. But as low cost becomes the dominant consideration in design, ceramic tends to prevail. However, MOS capacitors can be attached with the same equipment used for semiconductor die mounting and conventional wire bonding.

Typical chip prices in 10,000-piece lots range from 13 cents for low-value units to about 75 cents for high-value. Since the capacitors are deposited on a silicon substrate, many different values can be placed on a single silicon chip.

Dionics, for example, has its Models C-700 and C-1248, which contain capacitors that range from 1 to 39 pF on a 50 \( \times \) 35 \( \times \) 5-mil chip. The C-700 contains a total of 94 pF, while the C-1248 has a total of 15 pF—but on a chip about half the size.

**Chip inductors: Limited choice**

Miniature inductors in chip form have been available from only a few manufacturers because they are both hard to make and the very-high-volume demand for them just isn't there. The companies that do offer them have both fixed and variable types, with values from 1 nH all the way up to 10 mH. The variable types are usually available with a tunable range of about half a decade.

"Prices are starting to drop as more of the expensive hand labor needed for wound inductors is eliminated," says Bill Parker, vice president of technical and special components for Airco Speer.

However, the assembly of variable wound inductors is a very delicate operation, and their prices are still in the $3 to $5 range for small quantities—still cheap compared with the $15 to $20 of several years ago.

The cost of fixed units has also continued to decline as production techniques have improved or new methods have been found. Fixed inductors can be bought for as little as 29 cents each in large quantities.

Inductor size is perhaps the most critical factor, after the inductance value. Ultra-small deposited fixed units, such as the L-50 inductors made by Thinco, span a range of 1 to 120 nH and have a chip size of only 50 \( \times \) 80 \( \times \) 25 mils. These units are made by
Transistor and semiconductor technology once again sets the standard for semiconductors! Now, a new generation of Voltage Regulators and Transient Suppressors for protection of delicate logic circuits and sophisticated power supplies, providing protection against voltage transients in airborne-equipment as well as suppression of relay coil and contact noise.

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1500 watt Peak Pulse Power
Nominal Voltage: 10 to 110 V
Dynamic Impedance (max.): 0.7 to 35 Ohms
Dimensions (max.): Body .165"D x .165"L
Lead .040"D x 1.10"L

1975 NATIONAL SBA SUBCONTRACTOR OF THE YEAR

Contact factory for complete specifications.
vacuum-depositing sequential layers of insulation and metal so they form a square, flat coil. Larger inductor chips, made by Delevan, Nytronics, Vanguard and others, use wound coils of very fine wire that are epoxy-sealed in brick or cylindrical form. They come in sizes up to 250 mils square by 100 mils high.

Inductor manufacturers have had problems in maintaining the coil Q while providing the most inductance in the smallest space. The tradeoff is usually the lower Q, which for these small units is usually under 100, although the L-30 fixed units from Thincro are reported to have Qs as high as 260 at 400 MHz.

Most companies that offer chip inductors also make tuned circuits to custom requirements, since all they have to do is add a tap, or several resistors and a capacitor.

Resistance comes in many forms

Whether you need a high-value resistance or a low one, you have a choice of thick or thin films. Thick films tend to offer the lower cost but lack the temperature stability of thin-films.

Prices for thick-film resistor chips start at about 10 cents each in 10-k lots; thin-film resistors still cost about double that. Manufacturers of thin-film networks, like

Analog Devices, Hybrid Systems, LRC Microelectronics and National Semiconductor, all feel that as volume applications for thin-film networks increase, prices will drop to compete with those for thick-film circuits.

Thin-film networks are usually not available in chip form; usually they are part of the circuit substrate. Thin films, however, can be built with IC technology, which permits the networks to be treated the same as active chips.

The accuracies of thick-film resistors range from a poor 20% to a fairly tight 1%, with some 0.5% tolerances available on special orders. However, for most applications, trimming thick films to 0.5% is not the answer if tight tolerances are needed. This is because the temperature drift of thick films (depending upon formulation) can be as bad as 200 ppm/°C or as good as 50 ppm/°C.

Thin films have high stability

Thin-film networks, on the other hand, have typical stabilities of 25 ppm/°C and can be formulated down to about 5 ppm/°C. The ratio accuracies of the networks can be trimmed down to 0.001% with computer-controlled laser machines—quite a bit tighter than the accuracies of thick films.

Typical thick-film resistance values range from about 1 Ω to well over 10 MΩ. Mini-Systems offers thick-film chips that range in value up to 1000 MΩ and can handle up to 0.5 W. Their prices start at about 13 cents in 10-k lots, with the chip sizes ranging from 35 × 35 to over 100 × 100 mils.

Other companies—like Aircospeer, KDI Pyrofilm, Dale, Eltec and CTS Microelectronics—offer chip resistors that are designed for power handling, isolation and special circuit designs.

For instance, CTS manufactures the Ceradot series of cermet pellet resistors. The pellets range in size from 50 mils in diameter and 30 mils thick up to 100 mils diameter and 62 mils thick. Values go from 10 Ω to 1 MΩ. A typical application
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might be to mount the pellets in holes drilled in the circuit substrate and make contact to the top and bottom. Tolerances for the Ceradots can be as close as 1%, while the temperature drift of the resistance is about 300 ppm/°C. CTS also has rectangular resistor chips that cover a 200-Ω to 350-kΩ range.

If you need high resistance values, try the Eltec. It has thick-film resistor chips with resistances up to 10¹² Ω. Prices start at about 45 cents each in 10-kΩ lots and accuracies at 30%, narrowing to 5%.

**Bulk-Metal for high efficiency**

If your circuit needs call for high accuracy and high-stability resistors, thin films are the only way to go. Vishay has just entered the super-precision chip market with its Micro Chip series of 0.01 and 0.001% absolute accuracy Bulk-Metal film chip resistors. Temperature coefficients are down to 5 ppm/°C over a -55 to +150°C operating range. Resistance values at present are limited to 1 Ω to 10 kΩ, but higher values will be available shortly. Prices for these precision chips will be about $3 for 100-piece lots.

Analog Devices offers a thin-film custom service to buyers who fill out a form in the company's catalog. Prices for user-designed networks with 0.1% ratio accuracy typically cost $5 in 1000 quantities.

National Semiconductor has introduced thin-film networks that cost only 35 cents each in 100,000-piece lots. This is for 1% tolerance.

Typical thin-film resistance values range from 10 Ω to about 10 MΩ. Most networks are built on silicon that has a sheet resistivity of about 250 Ω/square. However, Jay of Micro Networks says that materials with sheet resistivities of 1000 Ω/square are “just around the corner.” This increased resistivity, he says, is needed to build the low-power circuits required.

**Prototype kits—a mixed bag**

Did you ever try to calculate the resistance value that you need for a circuit? Or the inductance or capacitance? The law of averages says that you won’t have that value available to plug in.

To counteract this boardroom problem, just about every chip company offers a designer's kit of chips. This could range from as few as five chips to several hundred, depending upon what you want to pay and your need. Typical kit prices range from $10 to $700. The kits are usually a great bargain, since they offer a wide selection of component values at a greatly reduced price.
When you’ve got a new product that excites 1,235 people at Wescon, you’ve got what they want. Bud has it!

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So if microprocessors figure in your future... watch for MICROPROCESSOR DESIGN... another service to the reader from Electronic Design.
Optical reader scans coded copy at 400 characters per second

A new low-cost optical page reader scans typewritten copy with a throughput rate equivalent to that of 20 to 30 computer keyboard operators.

The reader, which uses special typewritten copy that contains a bar code under each character, can scan a densely typewritten page in 10 seconds—400 characters per second—according to Gordon Baty, president of Taplin Business Machines, Burlington, MA, the system developer. The company recently changed its name to Context Corp.

The machine reads out data in an 8-bit ASCII format and also in the RS232C serial code at 4800 or 9600 baud. With modifications, other codes can be used.

Called the Model 101, the machine was developed for use as a minicomputer peripheral, Baty says. Typists use a special $30 ball for an IBM Selectric or Remington SE-100 typewriter.

The key to the system is a continuously rotating three-lens barrel that scans the copy and focuses the 0.024-in.-high code bars onto a fixed linear array of nine photocells. These cells are electronically gated to give an effective array of six four-bar cells. The electronics controlling this selection, according to Baty, provide the following advantages:

- The typewriter letters are rejected and only the bar codes are read.
- The proprietary bar code, which consists of four narrow or wide vertical bars and three narrow or wide spaces between the bars, reduces errors. It has a built-in parity check that prevents the reading of spots of dust or dirt.
- If error-free typewritten copy is used, the accuracy of the reader is better than 1 character in 25,000.

- The machine can read “free form” typing—numerical data, lines and corrections typed anywhere on the page—so long as the lines are within the system’s skew.

Jim McDermott
Eastern Editor
tolerance of ±0.070-in.

The Model 101 code, says Leland J. Hanchett, manager of advanced product development for Context, was chosen over previous codes for several reasons. The code corresponds to four bars and three spaces. Both the bars and the spaces are wide for a digital ONE, Hanchett explains, or narrow for a digital ZERO.

The basic code provides a seven-element array with 128 possibilities, but because the typewriter prints only 88 characters, the most easily recognized sets of 88 bars were chosen.

Use of the four-bar code aids in holding down reading errors, Hanchett notes. In contrast with other optical bar codes, he says, dust specks and other sources of optical noise, instead of making the system believe it is exposed to a false character, tend to make the bar code unreadable. The machine then provides an indication of unreadability.

For example, Hanchett explains, the dust speck is more likely to obscure the space between bars, producing three bars instead of four. The dirt may add another bar, making a total of five. The system electronics rejects such false readings.

Further, Hanchett points out, if the bar and space widths fall substantially outside the specified dimensions, it will be diagnosed as a “can’t read.”

On the other hand, Hanchett notes, with bar codes that follow the Teletype or ASCII format, the addition of a speck of dirt can add the equivalent of a bar and cause an error.

No timing errors

In the electronics for interpreting the bar codes, the Model 101 detection system starts a clock count at the beginning of every bar and every space, and it stops counting at the end of every bar and space.

In this way, Hanchett says, the system is free from the cumulative timing errors of ASCII coding methods. ASCII-coded systems use the timing circuits to generate a strobe, which samples whether a bar is present at predetermined intervals.

Another limitation of the ASCII method, Hanchett asserts, is that samples of the horizontal bars in the typed letters can be misconstrued as a code bar. For this reason, ASCII bar readers require that the first typed line coincide with a preprinted marker and that the paper be stepped in precise line increments. As a result, freeform typing cannot generally be used.

In the new reader a sheet is inserted, and it progresses beneath the rotating optical head at a uniform rate of 1.33 in/s. This head design was chosen, Hanchett says, to eliminate the drawbacks of scanning with mirrors, as well as those of mechanical systems that scan back and forth across the page.

The role of the rotating lens assembly is to illuminate the characters to be read and to focus the typewritten elements onto the nine-element photocell array.

The paper is drawn by a vacuum into a semicylinder shape as it travels under the reading head, Hanchett explains. Thus the lenses view the entire line at the constant focal length.

The optical drum rotates at 1800 rev/min or 30 rev/s, sweeping a beam of light across each line of typed characters. At the 30 rev/s drum speed, the light spot travels across the width of the page at about 1000 in/s.

Since the characters are typed at 10 per inch, each character in a line is illuminated for about 100 µs. This provides an instantaneous reading rate for a single lens of 10,000 characters per second.

However, because the rotating drum houses three pairs of illuminating and imaging lenses, the typed line is swept three times by a light spot per revolution.
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Electro nic Design 23, November 8, 1975

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Straight talk about IC sockets.

Integrated-circuit sockets are becoming such a household item, people are starting to forget something.

They're not all alike. And the differences can have a major impact on the performance and profitability of the products they're used in.

That's why we've decided to go over a few socket basics.

THE REASONS... AND THE RISKS.

All sockets serve basically the same purpose: they allow you to replace ICs without damaging either the IC or the PC board. In so doing, they make both design changes and field service economically feasible for you and your customer.

There's only one problem. When a socket fails, troubleshooting can be a nightmare—to a point where you'd have been better off without sockets in the first place. So it pays to be sure that the sockets you buy are right for your application.

CHOOSING THE RIGHT SOCKET.

Buying the right socket is much more than a matter of profile and price. It's matching the right one to the demands of your application.

For low-cost, high-volume products where the risk and consequences of socket failure are minimal—and where repeated IC insertion and high retention aren't required—buy the cheapest sockets that will do the job properly.

But for high-shock and vibration environments, or other situations where performance is critical, by all means get the best sockets money can buy.

At Augat, we understand these differences. That's why we make sockets for both needs, in the widest range of sizes and specifications in the industry—from 6 to 40 contacts, on .300", .400", and .600" centers. These include low-profile, LED, and test sockets, socket carrier assemblies, and more—with PC, wire-wrapping, and solder pocket terminations.

And thanks to high-volume, automated production economies, these sockets are priced competitively despite many features you can't get elsewhere.

SMALL POINTS MAKE A BIG DIFFERENCE.

It's amazing how the finer points of socket construction can affect reliability.

Take the material the contacts are made of. For repeated IC insertion and good retention no other material can match the beryllium copper used in all Augat PC sockets. Cost alone leads other producers to use other materials.

Designs vary, too. Among low-priced sockets, Augat's new low-profile series grip the IC lead along both flat sides, rather than by the edge, for best contact. And they'll take the full range of lead sizes, too.

Among premium sockets, Augat's Series 500 and 700 are the only ones in the world to include the two-piece machined contact assembly designed and perfected by Augat. While stamped "equivalents" abound, their looser tolerances have given rise to a series of pitfalls avoided by the Augat design:

In the important matter of flow soldering, both series again provide a decisive edge. The closed-end construction completely eliminates the possibility of flux or solder wicking.

These distinctions may seem small, but taken together, they're a good indication of how well the sockets you buy will stand up under long-term use. And in a market flooded with lookalikes, they're something to shop for.

A SUPPLIER YOU CAN COUNT ON.

As the pioneer and leader in the IC interconnection industry, Augat has always been the world's prime supplier of IC sockets.

Now, after completing a multi-million dollar program of vertical integration, we're better equipped than ever to maintain that position—by providing the best sockets, the best service, and the finest distributor network in the world.

For all the facts, send today for our new brochure. We're convinced that the more you know, the more you'll come to Augat for all your IC interconnection needs.

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INFORMATION RETRIEVAL NUMBER 25
KEPCO

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2. Automatic (inherent) overvoltage protection. There's no crowbar—there's no need for one.
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INFORMATION RETRIEVAL NUMBER 26
An independent FAA sought

The Federal Aviation Administration may regain its old place in government life through a father and son act. Sen. Barry Goldwater (R-AZ) and his son, Rep. Barry Goldwater Jr. (R-CA), have introduced bills in their respective chambers on Capitol Hill that would take the FAA out from under the Dept. of Transportation and once again make it an independent agency.

In 1967 the then independent Federal Aviation Agency ran its own show, but management experts argued—and won—the debate that resulted in all forms of transportation being lumped into one department. By stacking bureaucracies on top of one another Senator Goldwater contends, the Government has introduced some obvious shortcomings—such as adding 18 months or more to the FAA’s procurement process. Both father and son argue that independence will permit the agency to act more quickly to update its services and improve air safety.

Better distribution of NSF grants urged

Contending that there is a pattern of administrative abuses and mismanagement in the National Science Foundation, Sen. Jesse A. Helms (R-NC) has introduced a bill to provide a peer review and management system for awarding grants. A similar bill in the House has been introduced by Rep. John B. Conlan (R-AZ). Both bills are aimed at obtaining better nationwide distribution of grants and the blocking of projects of questionable value.

At present, there is no single decision process in the foundation. On all but the larger grants, the program officer has formidable power. The bills to amend the National Science Foundation Act of 1950 would, among other things, require a review of applications by a peer group of no less than five qualified individuals in a particular field. The NSF program officer could select half of the group from an approved list, the applicant could name 20% and the remaining 30%, chosen randomly.

Recent statistics, says Rep. Conlan, “show that NSF funding is restricted primarily to a small group of preferred institutions within a few states, with special preference to an elite corps of academic institutions heavily represented on the foundation’s advisory committees.”

Defense budget backers arm for new battles

The war over the Defense budget goes on with the Senate Armed Services Committee victorious over the Senate Budget Committee and the House of Representatives in the first engagement. But more battles lie ahead.
Just prior to the August recess, the Senate, at the urging of its new Budget Committee, refused to approve the conference report on the authorization bill, which was a stinging defeat for Sen. John Stennis (D-MS), chairman of the Armed Services Committee. Although the more liberal Senators wanted billions sliced from the bill, Senator Stennis and the other conferees reported back with a bill that was further trimmed by only $250-million. The Senate has now passed this version almost placidly, with the defense budget-cutters reserving their next attack for the appropriations bill passed by the House on Oct. 2.

The authorization for the coming 15 months now amounts to $30.9-billion. The conferees cut $60-million for a nuclear strike cruiser. The AWACS program still calls for six aircraft, but $60-million was cut from the program and spares. The Air Force F-15 program was reduced $22.3-million on all spares, in addition to AWACS, $22.7-million. The Navy's patrol frigate program was cut from 10 to nine vessels, saving $85-million.

With the “shopping list” bill out of the way, the Senate began considering a $112-billion appropriation bill, which would cut some $4.5-billion from the sum the Defense Dept. now plans to spend this year. A spirited fight is expected in the Senate, for example, over the AWACS program. The House, which reluctantly agreed to a six-plane program, voted money for only two planes.

According to the Senate Budget Committee, the House appropriation bill exceeds the Senate committee's guidelines by $700-million. A replay of the donnybrook on the authorization bill is assured, because this will be the last chance to cut defense spending during the next 15-month period that began on July 1.

California leads in defense contracts

When it comes to winning the defense dollar, California still reigns supreme, capturing one-sixth of the total procurement in the fiscal year that ended last June. According to the Defense Dept. Comptroller, the total value of military procurement for the year came to $43.3-billion; California contractors got nearly $8-billion of that.

New York State was second with $3.7-billion, followed by Connecticut, $2.3-billion, and Texas, slightly over $2-billion. States with more than $1-billion in contracts were Massachusetts, Washington, Missouri, Virginia, Pennslyvania, Florida and Ohio. Montana, with $5.1 million, received the smallest slice of the pie.

Capital Capsules: The Air Force has developed a Voice Input Code Identifier that enables a computer to recognize spoken digits and certain command words, say Air Force engineers, who tested it with a variety of regional accents. The identifier will be used with the Automated Speaker verification system for controlling entry to restricted areas. . . . The Army's Safeguard ballistic missile defense system became operational Oct. 1. It will not be deployed, however, due to terms of the U.S.-Soviet detente. . . . Libya is looking for $30-million worth of air control training equipment, including air traffic control, search and rescue and computer systems. . . . The Army's selection of the French-German air defense system, Roland II, over an American system is described by the Defense Dept. as "a major step forward in defense cooperation among NATO allies." . . . The Army is giving a longer reach to chaff dispensers by sending the jamming material via rocket. The projectile dispensers are powered by 2.75-inch rocket motors.
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scope is a single-channel, dc-to-5 MHz modular instrument with triggered sweep and vertical sensitivity to 10 mV/division.

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For complete information on how the 455 Portable Oscilloscope delivers the performance, versatility, and cost-saving effectiveness you need, contact your local Tektronix Field Engineer. Or write: Tektronix, Inc., Beaverton, Oregon 97077, for the new 455 applications and specifications brochure. In Europe, write Tektronix Limited, P.O. Box 36, St. Peter Port, Guernsey, Channel Islands.

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FOR TECHNICAL DATA CIRCLE #243
FOR DEMONSTRATION CIRCLE #244
HiNIL Interface

Keeping the bugs out of microprocessor systems with high noise immunity logic.

An MOS microprocessor system can be troubled by disastrous bugs unless it is protected against noise transients generated by switches, electromechanical peripherals and other nearby noise sources, such as lamps and machinery. But filters and shielding, the traditional cures, are often difficult to add to a microprocessor because of size and cost constraints.

This problem can be avoided by substituting HiNIL interface devices for conventional I/O logic. HiNIL—Teledyne’s bipolar High Noise Immunity Logic—has a guaranteed DC noise immunity about 10 times that of TTL, for example (3.5 vs. 0.4V). Also, HiNIL blocks AC transients large enough to cause TTL malfunctions. Two additional advantages are superior output drive and, in low power systems, protection of CMOS memory and random logic inputs.

The rules for using HiNIL with MOS or CMOS components operating at lower voltages are simple. The pullup resistor of an open collector HiNIL device is connected to the desired logic level voltage (see Figure 2). To use HiNIL with bipolar logic, just plug in a Teledyne dual or quad interface circuit (see table). HiNIL is also compatible with most analog devices.

Examples of HiNIL Interface Devices

- 301 Dual 5-I/O Power Gate
- 302 Quad Power NAND Gate (OC)
- 323 Quad NAND Gate (OC)
- 332 Hex Inverter (OC)
- 334 Strobe Hex Inverter (OC)
- 350 8-Bit Multiplexer
- 351 Dual 4-Bit Multiplexer
- 361 Dual Input Interface
- 362 Dual Output Interface
- 363 Quad Output Interface
- 367 Quad Schmitt Trigger
- 368 Quad Schmitt Trigger (OC)
- 380 BCD to Decimal Decoder (OC)
- 381 BCD to Decimal Decoder
- 382 BCD to 7 Segment Decoder
- 390 Interface Buffer Series

If you need a simple, inexpensive solution to a difficult noise problem, write or call Teledyne Semiconductor for a copy of application notes and specifications on Teledyne’s High Noise Immunity Logic family.

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INFORMATION RETRIEVAL NUMBER 28
Ignorance and apathy

Dan, an old buddy, telephoned the other day to relate a conversation. He was sipping some lemonade at the Wagon Wheel, a local culture center in California's Silicon Gulch, when he overheard two semiconductor executives.

"What's wrong with this industry," Will was philosophizing, "all boils down to two factors—ignorance and apathy." Jerry stirred his drink, steepled his hands, looked at the ceiling, then replied, "I don't know. And I don't give a hoot."

Jerry may have been kidding. But the story, even if apochryphal, is more sad than funny. It's sad on two counts. First, far too many of us don't know and don't care. And second, far too many of us don't know and don't care that we don't know and don't care.

We adjust too readily. When we see our own companies turning out shoddy products or engaging in practices that might be less than admirable, we close our eyes. We see nothing and want to see nothing. Maybe the social and economic setup makes us insecure and fearful. Or maybe we're too comfortable. And maybe our comfort is too easily shaken by our seeing things and giving voice to our consciences. Maybe our blinders help us drug our consciences. Unfortunately, conscience can't be buried. So there's one tragedy.

The second may be a blessing rather than a tragedy. Most of us can't see what we can't see—even when we are shown.

Tell one fellow that there's too much bigotry in the world. And he might agree, if he cares to agree, while denouncing Jews, or blacks, or women, or red-headed men, or Easterners or Westerners, or whomever. Tell a man there's too much conceit in the world and he might agree while hailing his own virtues. Tell an engineer there's too much equipment around that fails too readily and he might agree, while condemning those who don't use his designs with the utmost caution.

Maybe it's fortunate that most of us have a built-in mechanism to protect us from seeing some of our ugliness. But wouldn't it be better if we were secure enough and strong enough to see and care?

GEORGE ROSTKY
Editor-in-Chief
"THE GOLD BOOK IS A VERY RICH SOURCE FOR INFORMATION ON U.S. PRODUCTS"

Mr. Peter Kartaschoff is Head, General Radio Technology Section, R&D Center, of the Schweizerische Post, Telephon- und Telegrafenbetriebe (Swiss Postal Enterprise) in Bern, Switzerland.

The Post Office in Switzerland, as in most of Europe, is also responsible for communications, telephone and telegraph. The R&D Center is very important; what it specifies will be bought later in quantities. Mr. Kartaschoff told Electronic Design's Associate Editor, John Mason:

"We buy a wide range of special components for development work. We have a relatively good network of suppliers in Switzerland where we usually can get small quantities. But in the last few years we have sometimes had trouble in finding large quantities.

"Your GOLD BOOK is a very rich source of information on U.S. electronic products.

"If a piece or system can be bought on the market we tell our people, listen there it is. We'll buy it. We're not going to develop it ourselves because it's always cheaper to buy something than to develop it."

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INFORMATION RETRIEVAL NUMBER 30
Increase microcomputer efficiency with interrupt and DMA capabilities. A microprogrammed 
μP needs only seven extra ICs and six new instructions.

Two common features of large computers—
program interrupt and direct memory access (DMA)—can be readily applied to microcom-
puters. These features give micros a vast increase in processing efficiency.

Program interrupt allows external hardware to initiate program operations without continuous program monitoring. It also makes more time available for program operations by reducing time spent waiting for I/O devices to complete operations (see box).

The DMA feature provides controls for high-speed direct transfer of data between an I/O device and memory. No program intervention is required during the transfer. Data can be transferred at rates up to the maximum speed of the memory—much faster than would be possible under program control. And the DMA feature allows attachment to the microcomputer of high-transfer-rate devices, such as magnetic tape and disc units.

Moreover program interrupt and DMA can be simple to build into a microprocessor. A micro-
programmed processor, in particular, requires only seven additional ICs, six new instructions and nine extra control-ROM bits (Fig. 1).

Making decisions

Both interrupt and DMA operations occur between instructions. Thus these operations affect normal instruction fetch and execute sequences. At the end of each instruction the microprocessor must select the next sequence to be performed—execution of an interrupt, one of two DMA operations or the fetch and execution of a normal instruction.

This decision-making begins with the ROM address register (RAR) of Fig. 1. It clears to zero at the end of each instruction, so that ROM-address zero starts the next instruction fetch portion of the microprogram. A memory called the End-Op ROM decodes the status of the following lines: Interrupt Request (INTR), Interrupt Enable Flip-Flop (INTEN), DMA Request (DMAR), and DMA Write (DMAW). The decoding produces an address that is loaded into the RAR at the end of instruction execution.

If no interrupt or DMA requests are present, the ROM emits an address of zero, and RAR sets to the start of the next instruction-fetch sequence. If an Interrupt or DMA request is present—indicated by activation of the INTR and or the DMAR lines—the RAR loads with the starting address of the appropriate Interrupt, DMA Read or DMA Write sequence. The End-Op ROM is so coded that DMA operations have priority over interrupt operations. Also both INTEN and INTR lines must be active before the interrupt sequence can be selected. A flow chart of these operations appears in Fig. 2.

Once an interrupt request has been received and the execute sequence has been entered, the interrupt request must be disabled. Otherwise the hardware will continue to loop through the interrupt execute sequence. The End-Op ROM, enabled at the end of the interrupt sequence, continues to generate the sequence start address as long as INTR is active.

The INTE flip-flop overcomes this problem. It disables the interrupt request (INTR). And the INTE flip-flop clears during the interrupt sequence, and may be set—or cleared—under program control by new instructions.

The INTE flip-flop is loaded from the I/O bus and by bit 15 (least-significant bit). The circuit is set or cleared when the 6701s emit all ONEs or all ZEROs as data, respectively. Also the flip-flop must be clocked with an additional control-ROM bit.

The right time for requests

Interrupt and DMA requests can come at any time. However any request must be made available before the end of the microstep that enables the End-Op ROM.

Specifically these signals must be stable for one ROM access time plus a counter-load setup.

David C. Wyland, Microprocessor Design Manager, Monolithic Memories, 1165 E. Arques Ave., Sunnyvale, CA 94086.
Interrupt and DMA: μP time savers

Both program interrupt and direct-memory access capabilities conserve valuable microprocessor time. They allow a computer to devote most of its time to a long program, while simultaneously providing immediate response for shorter, more urgent functions.

The program-interrupt function provides what its name implies: the ability to suspend a running program to perform a higher-priority one. When the latter program is completed, the original one resumes.

One example of interrupt is printer buffering. Serial printers are often slow—about 10 characters per second. To print a line of characters without interrupt, the CPU transfers a character to the printer, waits 100 ms until that character is printed and then transfers the next character. This procedure repeats until all the characters in the line are printed. However, only a few microseconds are needed to transfer a character. So the microprocessor spends most of its time waiting for the completion of print operations.

The program-interrupt feature eliminates this waiting time. Now the printer causes a program interrupt when it has completed a character. And while the printer is busy, the microprocessor begins or continues the execution of a program.

When the printer interrupts current program operation, the microprocessor is forced to begin execution of a special interrupt-service routine. The interrupt-service program gets the next character to be printed, sends it to the printer and re-enables the interrupt. If the last character has been printed, no commands are sent to the printer. The microprocessor can return to the original program (usually called the background program) and continue operating. Processor time is required only for a few microseconds every 100 ms.

The direct-memory access (DMA) feature allows the high-speed transfer of data directly between the memory and an I/O device. Memory cycles are “stolen” from the processor for use by the I/O device that is transferring data.

Typically the DMA feature is used to transfer blocks of words to a list in memory. The I/O device supplies the memory address and data for each word to be transferred. It also contains the logic to increment the address to the next word on the list, count the number of words transferred and determine when the transfer is complete.

Direct-memory access must be used when data-transfer rates exceed those that are possible with program-controlled transfers. For example, a disc-file unit may require a byte of data every 3.2 μs. This can be easily too short for a program. Within the required interval, the program must do the following: detect the transfer request, get a byte from a list, transfer it to the disc unit, increment the list address counter, decrement the word counter and test the word counter for a zero result. But with DMA, the I/O device usually contains all the logic necessary to perform data transfer in one memory cycle—typically 1 μs.

DMA is also useful for low-speed block transfers, such as in the serial-printer example. And DMA can be used simply to make more processor time available. However, it is particularly useful for medium-speed devices with transfer rates of 1000 to 10,000 bytes per second.

If a device transfers data at 100 μs per byte (10,000 bytes/sec) and the interrupt service program requires 60 μs to run each interrupt, only 40% of the processor's time is available for the background program during the transfer. But if DMA transfer is used, only one 1-μs memory cycle will be “stolen” from the processor every 100 μs. Thus 99% of the microprocessor's time can be applied to the background program.

time and before the trailing edge of counter-load RAR clock. These signals are synchronized through clocking into flip-flops earlier in the microprogram, providing the settling time.

In our system a synchronizing flip-flop in each device requests an interrupt and/or DMA operation (Fig. 3). The flip-flops are clocked at the end of State 0, and they are clocked at appropriate points in the DMA and interrupt microprograms to ensure sufficient settling time. Timing diagrams for the DMA and interrupt operations appear in Fig. 4.

A microcomputer may have more than one DMA device, and more than one device may simultaneously request service. Thus a priority scheme is required to determine which gets serviced first. It also specifies whether a read or write operation is to be performed.

This priority selection is performed by the logic in Fig. 3. The DMA Request flip-flop sets at the end of State 0 of the microprogram, ensuring that at least one microprogram state exists before the End-Op ROM is enabled. It also ensures that at least two microprogram state times minus a ROM access time and counter setup time exist before all lines must be stable. During this period if any DMA Request flip-flops sets, the DMAR line (an open-collector OR bus) activates.

The priority of simultaneous requests is resolved in serial, “daisy chain” fashion: Each set of DMA request logic has a priority enable input, DMAP IN. If this input is low and the DMA Request flip-flop is set, I/O device logic is enabled.
1. A microcomputer employing bipolar processor slices (the 6701s) uses just seven additional ICs, six new instructions and nine extra control-ROM bits to obtain interrupt and direct-memory-access capabilities. This relatively simple implementation is possible because the 6701s are microprogrammable.
2. Decisions affecting interrupt and DMA requests focus on the End Op ROM. It determines whether the processor will perform a DMA operation, an interrupt sequence or a normal instruction fetch and execution.

3. Each I/O device contains all the logic needed to initiate interrupt and DMA transfers.

   to receive the next DMA cycle, and to drive the DMAW line, which controls read write selection.

   The DMAP IN line is permanently enabled, or grounded, for the highest priority device. Each set of logic generates a priority output signal, DMAP OUT, that goes to the DMAP IN input of the next lower priority device. This signal is normally low, unless the DMAP IN line is high or the DMA Request flip-flop is on. Either of these forces DMAP OUT high.

   (continued on page 74)

4. Both interrupt and DMA operations require special timing. The timing diagrams are segmented by micro-program steps defined in Fig. 6.
5. Data transfer for interrupt and DMA entails the use of these new instructions and additional control-ROM bits.

6. A portion of the microprogram is reserved for interrupt and DMA execution sequences.

Thus the DMA Request flip-flop of the highest-priority device seeking service disables all lower-priority devices. The flip-flop raises DMAP OUT, causing the DMAP IN lines of all lower-priority devices to go to the high, disabled state. Sufficient time must be allowed for this priority decision to ripple from the DMAP IN to DMAP OUT terminals of all devices in the request chain. The time is provided by the two microstep periods mentioned earlier.

A microcomputer may also have several devices that can request interrupts. In this case resolution of simultaneous requests transforms into a priority resolution of which interrupt program will be executed. And this can be determined by another program.

In our system, all interrupting devices activate a common interrupt-request line, INTR. The interrupt-execute sequence causes the program counter to be set to the address of a common interrupt-service program. This program determines which devices are currently requesting an interrupt, and it selects the highest-priority program for execution.

The advantages of this technique are that it minimizes the amount of hardware required and allows priorities to be set and modified under program control. However, the technique requires several program steps between the time that the interrupt request is generated and the beginning of the selected program's execution.

To implement the technique, the device logic of Fig. 3 has an open-collector driver that generates INTP. The driver's connection to the data bus determines priority; bit 0 has the highest priority, while bit 15 has the lowest. The driver is activated by a new control-ROM bit, GATE INTP (Fig. 5). The ROM bit, in turn, activates during execution of a new instruction, Load Interrupt Status (LIS).

This instruction causes all devices requesting an interrupt to activate their INTP drivers, and it loads the corresponding data on the bus into a selected register. In this way all interrupt requests become available to the program.

In some cases interrupt-request signals must be inhibited. This is called masking, and it is done with a simple flip-flop in each device (see Fig. 3). These mask flip-flops prevent the setting of other flip-flops that control interrupt requests. And they are loaded from the data bus by a new control-ROM bit, LD MASK, and the corresponding new instruction, Interrupt Mask. Mask flip-flops have their data inputs connected to the same bus bit as the INTP drivers mentioned earlier.

Masking can be used by a program to recognize interrupt requests of higher priority while a lower-priority interrupt program is processed. Simply mask all interrupt devices with a priority not exceeding that of the current interrupt and re-enable the interrupt system.

For the interrupt function to work properly, it must be possible to save all previous data and to restore it after the interrupt has been serviced. This is easily done for CPU registers and the program counter. However, we also must be able to save and restore the status indicators.

Two new Control ROM bits are required: GATE STAT, to place the status bits on the data bus for save operations, and LD STAT, to load the status bits from the bus for restore operations. Two new instructions—Save Status and Restore Status—are also required.

Three other control-ROM bits are required for DMA: DMAD, which causes the requesting DMA device to gate its address onto the data bus; DMAI N, which causes the DMA device to gate data onto the bus for write operations; and
DMAOUT, which strobos DMA memory data.

The execution sequences for interrupt and DMA operations appear in Fig. 6. The interrupt sequence causes the old program counter to be stored at the memory location defined by the contents of location 2. The program counter is then loaded with the contents of location 3—the location of the interrupt-service routine. The DMA execute sequences have an extra, dummy step that ensures a minimum of two steps between the request clock and the enable of the End-Op ROM.

Interrupt and DMA performance is measured by the maximum delay—or latency—between the submission of a request and the start of the corresponding execution sequence. Other important specs are the transfer rate for continuous DMA requests and the number of different maskable interrupt requests that the processor can recognize (Fig. 7).

DMA latency time equals the execution time of the longest instruction, assuming that the Request Enable clock came just after a request was submitted. Interrupt latency equals DMA latency plus one DMA cycle. This definition assumes that both an interrupt and DMA request were submitted simultaneously just after the Request clock and before execution of the longest instruction. The DMA transfer rate is equal to the inverse of the time required to pass once through the DMA sequence.

The interrupt and DMA implementations described have been kept simple in order to illustrate the problems and their solutions. However, many improvements can easily be added because of the microprogram control.

For example, the interrupt capability could be extended by the use of one 6701 as a last-in, first-out stack pointer for program-counter storage, and use of microcode to implement priority determination and program selection. Likewise the DMA sequences can be expanded to include such features as the use of memory locations as indirect DMA address and word counters.

References

7. A performance summary reveals latencies of only 2.4 µs for interrupts and 1.5 µs for DMA.
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HEWLETT PACKARD

Electronic Design 23, November 8, 1975
**Speed microprocessor responses** without interrupt or DMA techniques. Let the processor’s Ready line do the job, and build a simple floppy-disc interface.

Microcomputer designs don’t require techniques based on minicomputer hardware to achieve high speeds. Though designers often employ speed-enhancing interrupt or direct-memory-access (DMA) techniques borrowed from the mini world, the same improvements can be obtained far more simply. All that's needed is a microprocessor whose operations can be suspended readily during data transfers. Microprocessors like Intel’s 8080 permit just this kind of solution.

When applied to an 8080-based floppy-disc controller, the simple approach requires only about 20 ICs. By comparison, an interrupt structure uses 40 to 80 ICs, and a DMA approach needs 80 to 100. Moreover the 8080 exercises full format and timing control over floppy-disc functions, with all of the algorithms contained in less than 512 words of ROM.

**The alternatives**

Interrupt structures often require hardware that is external to the microprocessor, as well as special programming (Fig. 1). Further, high-speed applications can easily require all of the microprocessor's real-time capability. For this reason, other interrupt sources usually must be disabled during the execution of the high-speed routine. Also, it may be necessary to save—in advance—sensitive registers to increase the speed of the interrupt service routine.

After an interrupt in the application program, a series of vectors (either hardware or software) transfer program control to the interrupt-service routine. This routine is the actual program that performs the synchronized I/O transfer. After the servicing of the interrupt, control returns to the application program to prepare again for the next high-speed interrupt service. As many as 100 bytes of code may be needed to handle the high-speed interrupt. This doesn’t include the code for standard I/O that would be required without interrupt synchronization.

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**Eugene Fisher**, Design Engineer, Lawrence Livermore Laboratory, Livermore, CA 94550.
Debugging of this interrupt service is extremely difficult, since it cannot be effectively simulated on a separate computer. In fact, debugging is a very time-consuming effort, requiring the use of all of the system’s hardware or a trial-and-error method using oscilloscopes and other external hardware. This difficulty alone has discouraged designers. The typical speed for an interrupt interface is approximately 31,000 bytes per second.

Unlike the interface for a high-speed interrupt, the direct-memory-access interface isn’t really part of a microprocessor or microcomputer system. It actually is a separate hardware controller that communicates directly with the computer memory (Fig. 2). The only function a microprocessor has in these cases is to initialize the data channel.

Once DMA has begun, the microprocessor must be able to disconnect itself from the associated memory, so as not to inhibit the transfer. Thus debugging focuses on the hardware, because the only software functions employed are those needed for DMA-channel controls. The typical data-transfer rates are limited primarily by the memory. For example, memories for most single-chip MOS processors operate at 415 ns to 1 μs. So the data rate can be in excess of 100-k bytes per second.

A simple solution

An alternative approach—one that requires the µP to halt for each transfer—takes full advantage of the processor. The technique can be applied to any microprocessor that has Ready-line synchronization or otherwise allows the stopping of the processor for data transfers. The hardware to implement this synchronization appears in Fig. 3. The block diagram shows that a simple, external flip-flop can synchronize the microprocessor.

The circuit operates as follows: An I/O instruction—in this case an output from the microprocessor—clears the flip-flop, halting the processor with the I/O data available on the microprocessor’s data bus. The external device takes the data presented by the microprocessor and then returns a signal. Called DONE, the signal is used by the synchronizing flip-flop to raise the Ready line, letting the microprocessor continue. The microprocessor responds to an external input within one cycle—500 ns in our case.

Not only is this interface simple, but the microprocessor worst-case response is 1 μs. This response time is comparable to a DMA transfer, but with none of the associated hardware complexity. And the software is extremely simple; no difficult timing loops are required.

The output instruction actually stops the processor for a time that depends on the external device. If the microprocessor is already running at 100% utilization, there isn’t time for other operations anyway. Thus the time lost by halting the processor is of no real consequence. And now software for the output or input is merely a standard I/O operation, with synchronization and data timing taken care of automatically. The data rate is 62-k bytes per second—a program-execution limitation.

Employing the Ready line

The Ready line on the 8080 processor was designed primarily to interface the processor to a slow memory or a slow I/O operation. But while the processor is stopped, the data bus is present on the processor’s data lines. On an input instruction, the processor takes the data within 500 ns after starting or after the assertion of the Ready signal. After the Ready line is raised,
The synchronizing circuit for the Ready line employs two flip-flops, one for the output and one for the input. The microprocessor responds within the next clock cycle. Thus overall response is about 1 μs when a 500-ns clock is used with the 8080.

A typical Ready-line synchronization circuit appears in Fig. 4. Two synchronizing flip-flops are used, one for input and one for output from the peripheral. In both cases all synchronization is handled by an external flip-flop. Even the requirement for an external D-type flip-flop has been eliminated by a new clock driver recently announced by Intel. The synchronization of the Ready line can be taken care of by the new IC.

**Programming constraints**

The program must be able, of course, to accept synchronization by the external hardware. In the sample program (Fig. 5) the timing of each instruction in a critical loop has been calculated. This is necessary to ensure that the next I/O instruction is asserted in time. The routine allows the maximum data-transfer rate for the 8080 by employing the processor's stack pointer. By adding the two halves of the loop, we see that the maximum time between instructions is 16 μs. Also the response to an external stimulus is 1 μs. And the data rate for this interface is twice that possible in any equivalent interrupt-driven interface.

**Specifying the interface**

Our floppy-disc application employs the IBM format (Fig. 6). Note the different types of sector information. Each has a unique indicator—a Mark—for Index, Data, Deleted Data and Address. A Mark doesn't contain a full set of clock pulses, and the missing clocks and Mark words, form synchronizing elements. Another critical item is the cycle redundancy check (CRC) character. This appears at the end of each data sector. It must be read to determine if there has been an error in reading or writing.

The data rate in this format is 4 μs per data bit, with the clock pulses coming between each data pulse (Fig. 7). The data rate of the standard floppy disc is 4 × 8 bits/byte, or 32 μs per 8-bit byte. However, to eliminate any possibility of timing problems, the interface is designed for twice that rate, or 16 μs per 8-bit byte—an effective transfer rate of 62-k bytes per second. And to eliminate the need for double buffering, the previously collected data word is read before the next clock pulse occurs. This results in the 2-μs interval at our double speed.

**Solving interface problems**

The "missing"—but implied—clock signal is detected by a retriggerable, monostable multivibrator. With the aid of a separate clock signal from the floppy disc (Fig. 7b), the detected signal is then used to synchronize an 8-bit register and to generate an end-of-word signal. A 4-bit counter (Fig. 8) regenerates the missing pulses. The microprocessor's crystal clock

---

5. The time of each instruction in a critical loop must be calculated to ensure that I/O instructions are asserted soon enough. A portion of the read routine lists these times in microseconds.
6. An IBM data format applies to our floppy-disc example. Different sectors of information use an indicator known as a Mark. It relies on a series of implied—but not present—clock pulses for synchronization.

7. The Data Mark has a transfer rate of 2 µs per bit (a), or twice that of the usual format. This eliminates possible errors and the need for double buffering. The missing clock pulses are generated with the aid of a separate clock signal (b) from the floppy disc.

8. A simple 4-bit counter, synchronized to each separate-clock pulse from the floppy disc, regenerates the missing clocks.
each data word rather than at the end of a Mark word. The processor reads the data word at the end of each serial string in less than 1 μs, giving a 100% safety factor even for a floppy disc having twice the usual storage capacity.

The lower portion of the synchronizer controls Write operations for the Ready line. Three types of Write signals require synchronization: Write Mark, Write Data and Write CRC. Write Data simply writes the next 8-bit data word from the microprocessor into the shift register at the appropriate time. The Write Mark signal loads an 8-bit shift register (not shown), and this generates the missing clock lines for the writing of a Mark word.

Also on this shift register, Data Bit 6 is provided for one of the inputs, thereby allowing the software to create any of the three missing clock words required. The Write CRC command converts the CRC generator from a coded mode to a 16-bit shift register. The latter shifts out the collected CRC data word.

The control of the floppy disc functions—such as Head Load, Head Step In and Head Step Out—are handled in the usual I/O fashion, with flip-flops set to perform the required functions.

Key portions of the software for the floppy-disc application appear in Fig. 11. The first routine verifies that the floppy-disc head is actually on the correct track. The sequence is as follows: Wait for an address Mark; read the rest of the address sector; save the critical words of interest, the track and sector addresses; verify that there are no errors; then drop into a routine that steps the head to the desired track. Note that no critical timing loops are required. The only requirement is that the program return within 16 μs, so it can read the next data block.

Fig. 11b shows the code used to read a data block from the floppy disc and to store it in memory at the maximum transfer rate. This routine uses the processor’s stack pointer to store 16 bits or two bytes per operation (thereby transferring data at 16 μs per byte). Note that this code lists timing intervals in the comment, so the programmer can actually count the instruction times that will result.

Fig. 11c shows the code that writes a data file on the floppy disc. This routine is similar to the previous one. However, a preamble of zero words must be written before the actual data file. Also, the last CRC character must be followed with a zero word. ■

10. The Ready-line synchronizer for the floppy-disc application employs only four flip-flops and a few gates (a). The input Mark signal is sent twice (b) to detect address and data sectors.

11. Excerpts from the program, compiled by an 8080 macroassembler, illustrate the three major routines. The first, a search routine, checks to see that the disc head is properly positioned (a). The next routine reads a block of data in the disc and stores it in memory (b). The third routine writes data into the floppy disc (c).
<table>
<thead>
<tr>
<th>Address</th>
<th>Bits</th>
<th>Description</th>
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<tbody>
<tr>
<td>004403</td>
<td>365</td>
<td>STRT: PUSH PSW :SAVE A REG</td>
</tr>
<tr>
<td>004404</td>
<td>323</td>
<td>OUT HDDD :LOWER HEAD</td>
</tr>
<tr>
<td>004406</td>
<td>322</td>
<td>CALL LDDLY :WAIT FOR HEAD</td>
</tr>
<tr>
<td>004411</td>
<td>176</td>
<td>MOV A - M :TRK ADR</td>
</tr>
<tr>
<td>004412</td>
<td>376</td>
<td>CPI 112Q :TEST FOR TOO LARGE ADR</td>
</tr>
<tr>
<td>004414</td>
<td>322</td>
<td>JNC NOADER :ADR ERROR—Too LARGE</td>
</tr>
<tr>
<td>004417</td>
<td>317</td>
<td>CALL SEEK :STEP TO TRK</td>
</tr>
<tr>
<td>004422</td>
<td>315</td>
<td>CALL LDDLY :WAIT TO SETTLE</td>
</tr>
<tr>
<td>004425</td>
<td>333</td>
<td>IN RDMRK :SYNC AFTER STEP</td>
</tr>
<tr>
<td>004427</td>
<td>333</td>
<td>IN RDMRK :READ MARKS</td>
</tr>
<tr>
<td>004431</td>
<td>376</td>
<td>CPI 376Q :WAIT FOR ADR</td>
</tr>
<tr>
<td>004433</td>
<td>302</td>
<td>JNZ TSTRD :LOOP</td>
</tr>
<tr>
<td>004436</td>
<td>333</td>
<td>IN DATAR :TRK ADR</td>
</tr>
<tr>
<td>004440</td>
<td>107</td>
<td>MOV B - A :SAVE TRK ADR</td>
</tr>
<tr>
<td>004441</td>
<td>333</td>
<td>IN DATAR :ZEROS</td>
</tr>
<tr>
<td>004443</td>
<td>333</td>
<td>IN DATAR :SECTOR ADR</td>
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<tr>
<td>004445</td>
<td>333</td>
<td>IN DATAR :ZEROS</td>
</tr>
<tr>
<td>004447</td>
<td>333</td>
<td>IN DATAR :CRC</td>
</tr>
<tr>
<td>004451</td>
<td>333</td>
<td>IN DATAR :CRC</td>
</tr>
<tr>
<td>00453</td>
<td>333</td>
<td>IN DATAR :CRC DELAY WORD</td>
</tr>
<tr>
<td>00455</td>
<td>333</td>
<td>IN STAT :CHECK CRC</td>
</tr>
<tr>
<td>00457</td>
<td>027</td>
<td>RAL :SET UP FLAG</td>
</tr>
<tr>
<td>00460</td>
<td>332</td>
<td>JC ERROR :CRC ERROR</td>
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<tr>
<td>00463</td>
<td>072</td>
<td>LDA ADR :GET EXISTING ADR</td>
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<th>Address</th>
<th>Bits</th>
<th>Description</th>
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<tbody>
<tr>
<td>005064</td>
<td>333</td>
<td>READ: IN RDMRK :ENTER SECTOR ADR IN B</td>
</tr>
<tr>
<td>005066</td>
<td>376</td>
<td>CPI 376Q :LOOK FOR ADR MARK</td>
</tr>
<tr>
<td>005070</td>
<td>302</td>
<td>JNZ READ :LOOP BACK</td>
</tr>
<tr>
<td>005073</td>
<td>333</td>
<td>IN DATAR :SKIP TRK ADR</td>
</tr>
<tr>
<td>005075</td>
<td>333</td>
<td>IN DATAR :SKIP ZERO WORD</td>
</tr>
<tr>
<td>005077</td>
<td>333</td>
<td>IN DATAR :READ SECTOR ADR</td>
</tr>
<tr>
<td>005101</td>
<td>270</td>
<td>CMP B :TEST SECTOR</td>
</tr>
<tr>
<td>005102</td>
<td>302</td>
<td>JNZ READ :WRONG SECTOR—LOOP</td>
</tr>
<tr>
<td>005105</td>
<td>333</td>
<td>IN DATAR :ZEROS</td>
</tr>
<tr>
<td>005113</td>
<td>016</td>
<td>IN DATAR :CRC</td>
</tr>
<tr>
<td>005112</td>
<td>003</td>
<td>IN DATAR :CRC</td>
</tr>
<tr>
<td>005113</td>
<td>016</td>
<td>MVI C 13Q :SET UP JUNK-IN-GAP COUNTER</td>
</tr>
<tr>
<td>005115</td>
<td>333</td>
<td>IN DATAR :CRC DONE GAP WORD #1</td>
</tr>
<tr>
<td>005117</td>
<td>333</td>
<td>IN STAT :CHECK CRC</td>
</tr>
<tr>
<td>005121</td>
<td>02</td>
<td>RAL :SET UP FLAG</td>
</tr>
<tr>
<td>005122</td>
<td>332</td>
<td>JC CRER :CRC ERROR</td>
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<td>005125</td>
<td>333</td>
<td>CRAPLP: IN DATAR :SKIP THE JUNK-IN-THE-GAP—13 WORDS</td>
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<td>005127</td>
<td>015</td>
<td>DCR C :DONE—2.5</td>
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<tr>
<td>005130</td>
<td>302</td>
<td>JNZ CRAPLP :NOPE LOOP BACK—5</td>
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<tr>
<td>005131</td>
<td>004</td>
<td>LXI H - 0 :CLR H AND L</td>
</tr>
<tr>
<td>005136</td>
<td>071</td>
<td>DAD SP :ADD STACK POINTER</td>
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<tr>
<td>005137</td>
<td>042</td>
<td>SHLD TEMP :SAVE SP</td>
</tr>
<tr>
<td>005142</td>
<td>016</td>
<td>MVI C - 1000 :SET DATA CNTR</td>
</tr>
<tr>
<td>005144</td>
<td>061</td>
<td>LXI SP - BUFF :POINT TO BUFFER</td>
</tr>
<tr>
<td>005147</td>
<td>333</td>
<td>IN RDMRK :WAIT FOR DATA</td>
</tr>
<tr>
<td>005151</td>
<td>376</td>
<td>CPI 373Q :TEST FOR DATA MARK —3.5</td>
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<tr>
<td>005153</td>
<td>302</td>
<td>JNZ CRER :NOT A CRC ERROR BUT GET OUT FOR NOW —5</td>
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<td>005156</td>
<td>333</td>
<td>IN DATAR :FIRST WORD —5.5</td>
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<tr>
<td>005160</td>
<td>147</td>
<td>MOV H - A :SET UP —2.5</td>
</tr>
<tr>
<td>005161</td>
<td>333</td>
<td>ROVR: IN DATAR :READ ONE WORD—5.5</td>
</tr>
<tr>
<td>005163</td>
<td>157</td>
<td>MOV L - A :SAVE —2.5</td>
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<tr>
<td>005164</td>
<td>015</td>
<td>DCR C :BUMP CNTR —2.5</td>
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<td>005165</td>
<td>345</td>
<td>PUS H :STORE TWO WORDS —5.5</td>
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<td>333</td>
<td>DATCOL: IN DATAR :NEXT—AND CRC WORD 1 —5.5</td>
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<td>147</td>
<td>MOV H - A :SET UP WORD—2.5</td>
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<td>302</td>
<td>JNZ ROVR :AGAIN—5</td>
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<td>005174</td>
<td>333</td>
<td>IN DATAR :CRC WORD 2</td>
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<td>005176</td>
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<td>IN DATAR :CRC DELAY WORD</td>
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<td>IN STAT :CHECK STATUS</td>
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<td>005202</td>
<td>027</td>
<td>RAL :SET UP FLAG</td>
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<tr>
<td>005203</td>
<td>052</td>
<td>LHLD TEMP :GET THE STACK POINTER</td>
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<tr>
<td>005206</td>
<td>371</td>
<td>SPHL :RESTORE SP</td>
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<tr>
<td>005207</td>
<td>332</td>
<td>JC CRER :CRC ERROR</td>
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<tr>
<td>005212</td>
<td>311</td>
<td>LDDLY :WE MADE IT</td>
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<tr>
<td>005213</td>
<td>052</td>
<td>CRERX: LHLD TEMP :GET THE STACK POINTER</td>
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<td>005216</td>
<td>371</td>
<td>SPHL :RESTORE SP</td>
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<td>005204</td>
<td>174</td>
<td>OVR: MOV A - H :SET UP NEXT WORD —2.5</td>
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<td>005205</td>
<td>323</td>
<td>OUT DATAW :WAIT FOR DISC—5.5</td>
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<td>005207</td>
<td>344</td>
<td>DATWT: POP H :GET TWO WORDS —5</td>
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<td>005203</td>
<td>175</td>
<td>MOV A - L :NEXT WORD —2.5</td>
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<td>005203</td>
<td>323</td>
<td>OUT DATAW :WAIT FOR DISC—5.5</td>
</tr>
<tr>
<td>005203</td>
<td>015</td>
<td>DCR C :BUMP CNTR —2.5</td>
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<td>363</td>
<td>JNZ OVR :OVERS—5</td>
</tr>
<tr>
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<td>174</td>
<td>MOV A - H :SET UP LAST WORD</td>
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<tr>
<td>005204</td>
<td>323</td>
<td>OUT DATAW :OUT LAST WORD</td>
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<td>323</td>
<td>OUT CRC :SHIFT OUT CRC</td>
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<td>323</td>
<td>OUT CRC :IBID</td>
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<tr>
<td>005207</td>
<td>257</td>
<td>XRA A :CLEAR THE A</td>
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<td>323</td>
<td>OUT DATAW :WRITE OFF —LAST WORD IS ZEROS</td>
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<td>LHLD TEMP :GET SP</td>
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<td>005207</td>
<td>371</td>
<td>SPHL :RESTORE SP</td>
</tr>
<tr>
<td>005207</td>
<td>311</td>
<td>RET :FAREWELL</td>
</tr>
</tbody>
</table>
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Standard Resistance Values
R (Ohms), ± 2% Tolerance

<table>
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<th>R</th>
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Characteristic Impedance Zo

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<td>132</td>
</tr>
<tr>
<td>330/680</td>
<td>222</td>
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</tbody>
</table>

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**Design for fault isolation:** Increasingly, the man who creates the circuit must ensure that it can be easily tested. Here are some techniques to do just that.

Largely overlooked in the search for solutions to the problem of fault isolation has been the designer who creates the circuits to be tested and diagnosed.

Fortunately, this situation is now changing. The realization is growing that the designer not only has a responsibility in this area, but also has available a number of rather simple-to-implement techniques that can significantly reduce the cost and complexity of fault isolation.

These techniques permit the subsequent fault-isolation test system to observe and control specific elements within a circuit so that meaningful tests can be made.

The difficulty and cost of fault isolation has risen in direct proportion to the density and complexity of today's circuitry. Dozens of IC devices of a circuit board can be the equivalent of hundreds of thousands of individual components and circuit connections. Moreover, most of the problem points are out of reach, and the effect of individual faults can be masked by intermittent failures, fanouts, and errors that occur only when a particular logic sequence is performed.

For the production department, fault isolation has long been a growing and frustrating problem. Go no-go testing becomes a meaningless exercise when the percentage of no-go assemblies exceeds the half-way mark. Skilled personnel are siphoned into rework activities, and production-labor costs continue to climb in an industry that depends on IC technology for its future profits.

**Fault isolation and computers**

Similar frustrations are being encountered in the field at repair centers and service depots. A 25¢ device may be the only item that needs replacement, but the cost to locate the faulty IC package often exceeds the value of the complete circuit board or assembly. And, again, there is the problem to find and train the skilled personnel needed to do the work. Not surprisingly, then,
a great deal of attention is now being applied to the technology of fault isolation.

Theoretical work, much of it performed at the university level, finds expression in computer-controlled diagnostic schemes. Do-it-yourself test systems are being replaced with more sophisticated equipment from companies who specialize in this field. Larger manufacturers are developing staffs, strictly for fault isolation, composed of experts in the theory and implementation of diagnostic techniques.

But the net effect of much of this activity has been to replace one cost problem with another. Computer software and programming can make the cure as expensive as the disease. New fault-isolation systems, with computer-like logic but without the need for computer programming, are now becoming available. At best, however, the new systems will just hold the line in the face of increasing circuit complexity.

All of these difficulties can be largely overcome, if the designer—with the support of production, service and management—recognizes the interplay between design and fault isolation, and takes advantage of the cost-savings opportunities at his disposal.

The designer may, for example, increase the size of an edgeboard connector to accommodate test points for factory-level tests. The extra cost will probably be insignificant compared with the easing of the fault-isolation problem.

In general, fault-isolation testing consists of the creation of a particular set of conditions or sequence of conditions that permit the designer to observe whether the circuit performs as intended.

To do this is not necessarily a simple matter, especially when the objective is to narrow the test to a particular component or device. The designer is primarily interested in the over-all performance of the circuit assembly, but the fault-isolator must have a way to control specific elements within the circuit to apply meaningful tests to individual devices or groups of components.

The first task of the designer, therefore, is to add to the controllability of his circuit.

His second requirement is to increase the observability of the circuitry under test. Usually only a small fraction of the internal-circuit nodes are brought out for functional purposes. Obviously, it would be impossible to bring out all the nodes just for test purposes. The answer lies in a careful selection of extra test lines and a physical design that lends itself to easy probing with IC clips, oscilloscope leads, and other test-equipment connections.

Controllability and observability are separate, yet interrelated, functions, and the circuit designer can contribute importantly to both. A number of examples show how.

**Designing for controllability**

On power-up, flip-flops or any memory holding device can come up in any state. A long shift register will therefore require a long series of input pulses to flush out the unknowns. This extends the test time and a larger test-system memory may be required. The solution is to use a master-reset line, even if there is no need for the line in the circuit function. Bring the master reset line out to a pin for accessibility.

Some circuits include a power-up clear to provide the initial condition. This circuit is active only when the power is initially applied to the board. Figure 1 shows two alternative ways to

---

3. Test-system lines (1 and 2) are assigned to check receivers and transmitters that share a bidirectional line.

4. Feedback loops are hard to test. A control line can be used to stop errors at a gate during test.
provide external control signals to test both the power-up clear circuits and the reset line of the internal flip-flops.

Astable multivibrators that turn asynchronously can make testing very difficult because there is no time reference with which to make consistent tests. The solution here is to design control lines to the clock circuit to enable or disable the clock, or to let one clock pulse go out at a time.

The control lines will let the fault-isolation system exercise the circuit one clock at a time, and thus process the data at the system's own speed. One typical clock circuit is shown in Fig. 2. The input, when LOW, disables the clock. When HIGH or left open, the input enables the clock. An alternative solution is to provide a port for an external clock, as well as a clock disable.

With dynamic MOS circuits, provision must be made to synchronize the test system and the device under test. In the case of built-in clocks, provide either alternate inputs for external clocks or some method to synchronize to the internal one.

With bidirectional lines—where the line is shared by both a receiver and a transmitter—testing becomes complicated unless there is prior knowledge as to which circuit is active. It is advisable, therefore, to bring out the enable terms so that the system can test or troubleshoot the receiver and transmitter independently. To do this, assign test-system lines one and two as output (response) pins and test transmitters (Fig. 3).

Troubleshooting of circuits with feedback loops can be very difficult because errors tend to propagate and feed back to the origin (or seemingly to the origin). To provide a method for fault isolation, the designer can use control points without the sacrifice of circuit performance or addition of parts. For instance, one of the inverters could be an AND gate that provides an external control within the loop so that the loop can be broken in the middle by an input signal (Fig. 4).

In Fig. 4, with the control line disabled during troubleshooting, errors will not propagate beyond the gate. (The control line is permanently enabled during normal operation.)

**Regulators, ROMs and RAMs**

It is common practice to place a +5-V regulator on a printed circuit board. However, designers often neglect to bring out a test point to check the regulator. Malfunctions in the $V_{cc}$ regulator will cause massive errors or—worse—unpredictable, intermittent errors, commonly known as ghosts. It is therefore imperative to check the $V_{cc}$ regulator on the board before diagnostic attempts are made.

It is also advisable to provide some control for voltage margin. Many circuit malfunctions occur at voltage margins. To eliminate "weak sisters" and thus enhance the reliability of the equipment, circuits should be exercised at marginal conditions before installation (Fig. 5).

Circuits that use ROMs to replace hard-wired logic tend to have many feedback loops. In many cases, technicians troubleshoot the ROMs along with the rest of the circuit—a practice that can lead to confusion. Therefore, it is best to install sockets for the ROMs so that the memories can be checked prior to installation on the board. This not only simplifies the test but also provides a breakpoint in the loops.

The sockets can also be used to connect to the test equipment during checkout. Thus the test system can be directed to generate ROM patterns while the system monitors the results coming back as inputs to the ROM. (Inputs to the ROM for address lines are usually a function of the previous ROM address pattern.)

Circuits with ROMs also tend to have many jumps and subroutines so that it is often difficult to verify whether the instruction sequence follows the right course. Single-step capability is easy to implement at points where an external break is advisable.

To test large RAM systems requires specialized test equipment. However small memories embedded in a large circuit board may be easily tested by provision of some access for external controls, such as READ or WRITE.

In the usual circuit implementation, a memory READ cycle forms a subcycle of a CPU instruction. Therefore, it may not be possible to exercise a READ cycle without going through all the motions. If it can be done without unbearable cost and long delay in the development cycle, provide pins for external READ and WRITE commands.
(data input and output can be monitored by means of an IC clip).

For dynamic MOS RAMs, refresh requirements present some degree of difficulty. The strategy here is to first thoroughly check out the refresh logic, then test the memory.

One shots, ghosts and fanouts

Verification of the pulse width of a one-shot circuit can be easily handled by test systems with programmable sample clocks. However, most test systems have a fixed resolution and a minimum sampling time period, which makes it easier to check a long than a very short pulse width. If possible, therefore, make the pulse width at least as a general rule, boards should have a minimum number of connector varieties. Avoid connectors on more than one side of the board, multiple-connector types and connectors in the middle of the board.

Provision for extra test points is very important. However, the points must be easily accessible if they are to be of value. Use of extra edge-connector pins to bring out the test points can minimize test time and simplify the test fixture design.

More thought should be given as to what constitutes a good test point: Each test point should be an internal circuit node that can give the test system an important clue to the nature of possible failures (Fig. 6).

Most test-systems use IC clips to monitor circuit operations during troubleshooting. Often, the ICs are so close that it is impossible to use the clip. Sometimes discrete components get in the way or ICs are inserted in more than one direction. These problems must be avoided during the layout stage. At this stage, component locations should be numbered and the numbers should be easily visible on the board.

Jumper options can be tested most easily if all the jumping is done on the edge connector. However, if the board is not designed in this fashion, a set of parallel access lines should be provided, at the least, so that the tester automatically can exercise all the possible jumper configurations. Unused jumper options and their verification are often overlooked, and circuit malfunctions traceable to the jumper options are sometimes hard to diagnose.

It is common for a printed-circuit-board assembly to go through engineering changes after it has been put into production. Some of the changes will be temporary fixes. The manner in which these changes are incorporated will affect the tests. If an IC clip is to be used during testing, it is advisable to avoid the “dead-­bug” method. If a “bed-of-nails” fixture is to be used, consideration must be given to accessibility before jumpers are added.

Design for simplicity

To ease diagnosis and test-program generation on an automatic tester, circuits can be laid out to use a common test routine. For example, in Fig. 6a an automatic card tester with an IC-clip probe is used for diagnostics. The two 7400 gates are laid out on the printed-circuit board in such a way that a test routine for one chip can also be used for the other (the clock is connected to pin 2 on both chips).

By contrast, the circuit in Fig. 6b has the clocks connected to pin 2 of one chip and pin 1 of the other so that a common test routine is

---

**Diagram Description**

6. Two gates are laid out on a PC card so that each uses the same test routine (a). This can't be done with setup in "b."

1 μs, or greater.

A common occurrence is for errors to disappear when a scope probe is placed in an IC pin. This can be traced to changes in dynamic and static loading characteristics. The problem can become worse if the test system is directly interfaced with the internal circuit outputs.

For instance, standard TTL fanouts are usually limited to 10. If the tester receiver(s) is connected directly to an output node with the maximum fanout, circuit behavior may become erratic. A CMOS buffer can prevent loading but this can increase the cost of the test system (CMOS chips are also very slow). The design engineer can resolve this problem by limiting the number of fanouts to one less than the nominal maximum.

Designing for observability

It may not always be possible to design circuit boards with identical edge connectors. However,
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7. Schematics are as important as tests. Shown are all vital internal nodes, sources, destinations, and important circuit data, such as a one-shot's timing.

impossible. This example also pertains to testers that handle input signals as well as output.

Unused inputs, gates, flip-flops and other devices can also be tied to a known state to simplify the diagnostics. For example, if half of a 7474 flip-flop chip is not used, the output state will be unknown on power-up. Therefore, it will be difficult to program diagnostics for that chip. To eliminate the problem, tie the reset side to ground.

If identical pin assignments can be achieved throughout the system, as in systems that use mother boards, fixturing (as well as programming) becomes simpler. Since the stimulus and response pin definition is identical, most of the test-routine for one board can be used for the rest.

In any event, the designer should make an effort to simplify the connection scheme by assigning common power connections. Since most computer-controlled testers have the capability to change the input and output definition, the same interface fixture can be used for a number of different cards, as long as the cards have the same power connection.

Aside from test specifications and test procedures, a well-designed schematic can be a great help to test personnel. Schematics must be not just easy to follow, but should also provide test information as well. Such information can include a timing diagram, IC types and pin-out chart, a notation for I/O pins that is different from the internal connections, and the pulse width of one shots.

Figure 7 shows that "A" and "D" are edge-connections and that their pin numbers are 85 and 42, respectively; while "B" and "C" are internal connections and their source and designations are on page two and three, respectively. Also shown is a one-shot with its time-out classified as 12 μs with ±2-μs tolerance. **
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Complacent about resistor reliability?
There are at least 18 ways these components can cause circuit problems. Here are tests to ensure reliability.

Fixed resistors of the molded-composition and film types generally have such a good reputation for reliability that many design engineers seldom question it—until it’s too late. Their reputation, usually well-deserved, is kept that way because the leading manufacturers subject their resistors to stringent inspection and testing. Laxity in any phase of resistor testing can easily result in poor circuit performance when a completed assembly is put through environmental tests.

To ensure reliability, resistors must undergo at least 18 tests. Here they are:

- **Group 1**
  - Visual and mechanical inspection.
  - Resistance value and tolerance.

- **Group 2**
  - Resistance-temperature characteristics.
  - Resistance-voltage coefficient.
  - Dielectric withstanding voltage.
  - Insulation resistance.

- **Group 3**
  - Low-temperature operation.
  - Temperature cycling.
  - Steady-state humidity.
  - Short-time overload.

- **Group 4**
  - Load life.

- **Group 5**
  - Terminal strength.
  - Effect of solder heat temperature.

- **Group 6**
  - Solderability.

- **Group 7**
  - Shock and vibration.

- **Group 8**
  - Pulse applications.

- **Group 9**
  - Resistance to effects of solvents.

- **Group 10**
  - Temp/humidity cycling.

Because of the impracticality of testing every one of a large batch of resistors, select samples at random. For each test sequence, except the first group, pick 10 resistors of each type and resistance value.

The tests in Group 1—visual and mechanical inspection and resistance tolerance—are applied to all of the specimens. And within each group the tests should be made in the sequence shown. Some tests, such as groups 4, 6, 7, 8, 9 and 10, may damage or render the resistors unfit for further tests, thus they include only a single test.

In testing to compare the products of several manufacturers, use resistor samples with the narrowest standard tolerances. The resistance values should include the manufacturer’s lowest and highest standard values as well as the “critical.”

The critical resistance value is defined as the highest standard value that can safely dissipate full-rated wattage at 70 °C when a maximum-rated, continuous-working voltage (RCWV) is applied. The maximum RCWV for dc or rms voltages is supplied by the manufacturers. Table 1 lists RCWV values for common hot-molded fixed resistors.

All resistors, except those that are truly hermetically sealed, absorb moisture. Since this can affect resistance values, you must remove the moisture. This operation on test samples, often called conditioning, is done by exposing the resistors to warm, dry air from a ventilated oven in an air-conditioned space. For the resistors in Table 1, apply dry 100-C air for the conditioning time listed. Longer drying may be required if the resistors have been stored for long periods under unusually high relative humidity.

### Resistance to resistance change

Of course, a resistor’s ohmic value and its tolerance range are the most important specifications. The ohmic values should be within the specified tolerance when measured at 25 °C. And because composition and some film resistors exhibit a voltage coefficient, measure the resistance with standardized voltage levels, so the measurement error doesn’t exceed one-tenth the allowable resistance tolerance.

The use of specific dc test voltages, as in Table

Don Bugalski, Manager Fixed Resistors, and Jack Polakowski, Fixed Resistor Applications Engineer, Allen-Bradley Co., Electronics Div., Milwaukee, WI 53205
Table 1. Test limits for hot-molded fixed resistors

<table>
<thead>
<tr>
<th>Maximum continuous power rating at 70°C ambient watts</th>
<th>Maximum rated continuous working voltage (RCWV) dc or rms volts</th>
<th>Dielectric withstanding voltage volts at 30° Hg sea level</th>
<th>Dielectric withstanding voltage volts at 3.4° Hg 50,000 ft.</th>
<th>Insulation resistance test voltage volts ±10%</th>
<th>Short-time overload voltage limit volts</th>
<th>Recommended conditioning time at 100°C +5°C -0°C hours</th>
<th>Critical resistance value megaohms</th>
</tr>
</thead>
<tbody>
<tr>
<td>1/8</td>
<td>150</td>
<td>300</td>
<td>200</td>
<td>100</td>
<td>200</td>
<td>25</td>
<td>0.18</td>
</tr>
<tr>
<td>1/4</td>
<td>250</td>
<td>500</td>
<td>325</td>
<td>100</td>
<td>400</td>
<td>50</td>
<td>0.27</td>
</tr>
<tr>
<td>1/2</td>
<td>350</td>
<td>700</td>
<td>450</td>
<td>500</td>
<td>700</td>
<td>75</td>
<td>0.27</td>
</tr>
<tr>
<td>1</td>
<td>500</td>
<td>1000</td>
<td>625</td>
<td>500</td>
<td>1000</td>
<td>120</td>
<td>0.27</td>
</tr>
<tr>
<td>2</td>
<td>750</td>
<td>1500</td>
<td>625</td>
<td>500</td>
<td>1000</td>
<td>130</td>
<td>0.30</td>
</tr>
<tr>
<td>3</td>
<td>500</td>
<td>1000</td>
<td>625</td>
<td>500</td>
<td>1000</td>
<td>120</td>
<td>0.091</td>
</tr>
<tr>
<td>4</td>
<td>750</td>
<td>1500</td>
<td>625</td>
<td>500</td>
<td>1000</td>
<td>130</td>
<td>0.15</td>
</tr>
</tbody>
</table>

Table 2. Recommended resistance measurement voltages

<table>
<thead>
<tr>
<th>Nominal resistance range</th>
<th>Test voltages (dc volts)</th>
</tr>
</thead>
<tbody>
<tr>
<td>1.0 to 9.1 ohms</td>
<td>0.3</td>
</tr>
<tr>
<td>10 to 91 ohms</td>
<td>1.0</td>
</tr>
<tr>
<td>100 to 910 ohms</td>
<td>3.0</td>
</tr>
<tr>
<td>1K to 9.1K ohms</td>
<td>10.0</td>
</tr>
<tr>
<td>10K to 91K ohms</td>
<td>30.0</td>
</tr>
<tr>
<td>0.1 Meg. and Higher</td>
<td>100.0</td>
</tr>
</tbody>
</table>

Table 3. Temperature characteristic test sequence

<table>
<thead>
<tr>
<th>Sequence</th>
<th>Ambient temperature °C</th>
</tr>
</thead>
<tbody>
<tr>
<td>A</td>
<td>105</td>
</tr>
<tr>
<td>B</td>
<td>85</td>
</tr>
<tr>
<td>C</td>
<td>55</td>
</tr>
<tr>
<td>D</td>
<td>25</td>
</tr>
<tr>
<td>E</td>
<td>0</td>
</tr>
<tr>
<td>F</td>
<td>- 25</td>
</tr>
<tr>
<td>G</td>
<td>- 55</td>
</tr>
</tbody>
</table>

2, is recommended for all performance tests. Apply these voltages for the shortest possible time to avoid heating. Wherever practical, use the same instrument and the same temperature (within ±2°C) in all tests. Wheatstone-bridge test equipment is preferred.

To evaluate resistance-temperature characteristics, maintain the resistors within ±1°C at each of the ambient temperatures in Table 3 and in the sequence shown. The use of forced circulating air is recommended to assure temperature stability and uniformity. Make the resistance measurements 15 minutes after the air temperature has stabilized at each specified temperature. The percent difference in resistance, referred to the resistance at +25°C, is computed by the equation

$$\frac{(R - r) \times 100}{R}$$

where R is the resistance at the test temperature and r is the resistance at +25°C.

The resistance-voltage coefficient—often called instantaneous voltage coefficient—is normally important only in testing; it allows accurate comparison of the results. Measure the resistance values for calculating the voltage coefficient at one-tenth RCWV and full RCWV. And remember to apply the voltages for a short time to minimize heating. The voltage coefficient is calculated from

$$\frac{R \times 0.9 (RCWV)}{\left( \frac{R - r}{R} \right) \times 100}$$

where R is the resistance at full RCWV and r is the resistance at one-tenth RCWV.

The next test is to check the resistors' dielectric withstanding voltage. Clamp the resistors in the trough of a metallic 90-degree V-block. The resistor body should not extend beyond the ends of the trough, and the resistor leads should be parallel to the sides of the V-block.

Apply sine-wave voltage at commercial-line frequency and at the levels specified for the resistors under test (Table 1). The voltage should be applied between the V-block and both resistor terminals, with the terminals connected together. Raise the voltage at 100 V/s and hold it for 5 s.

Note that Table 1 provides two sets of test voltages. One is for a sea-level pressure of about
30 in. of mercury, and the other is for atmospheric testing at about 3.4 in., which corresponds to an altitude of 50,000 ft.

A companion test to withstanding voltage is insulation resistance. Clamp the resistors between a round nonconducting rod, placed at right angles to the resistor body, and a resilient conductive material about 0.075-in. thick, bonded to a rigid metal strap (Fig. 1). Apply sufficient pressure to embed the resistor color bands in the resilient material and to provide intimate electrical contact along the entire axial length of the resistor body.

The metal strap and resilient conductive material should be as wide as the length of the resistor body, and the resistor should be placed in the center of the strap. The resistivity of the resilient conducting material must be less than 1000 Ω-cm.

Avoid excessive resistor handling to minimize the effects of perspiration or other contaminants. Connect the lead wires of the resistor together and measure the resistance between these leads and the metal strap. Use the manufacturer’s specified dc test voltage. Table 1 provides test voltages for hot-molded resistors. Check the values obtained against the manufacturer’s limits.

Testing for performance at extremes

To test for the effects of very low temperature, mount the resistors by their leads so there is at least 1 in. of free air space around each resistor, with no appreciable obstruction to the flow of air.

Measure the initial resistance. Then expose the resistors to an air stream of −65 C for 1 h, with no voltage applied. Follow this with 45 min of exposure, but with the RCWV applied. Allow the resistors to return to room temperature and to remain there for 24 h, then make a final measurement of resistance. Note any deviation from the manufacturer’s spec.

Temperature cycling is an even more severe test of a resistor’s ability to withstand temperature extremes without permanent change of resistance. Again, measure initial resistance with the resistors mounted for low-temperature evaluation. The temperature-cycling sequence in Table 4 is frequently used by manufacturers. It shows four steps. The temperatures in steps 1 and 3 are obtained by forced-air circulation. The heat source should push the air temperature within 2 min to the temperatures specified in the table. Measure the final resistance about 1 h after completion of the last cycle.

Moisture also can permanently change a resistor’s value. Though the results of humidity tests are hard to reproduce and compare, the following procedure has proved effective as a steady-state test:

Measure the initial resistance values, avoiding excessive handling. Place the resistors in a chamber with relative humidity of 90 to 95% at an ambient temperature of 40 C for 240 h. Then remove the resistors from the chamber and allow them to dry at room ambient for 4 h. This removes only surface moisture. Final resistance measurements can then be made.

To determine if any resistance changes are permanent, the resistors may be conditioned, as described previously, and the values checked again.

A more realistic approach to humidity testing is sequential exposures of high temperature followed by high humidity. After measurement of the initial resistance, put the resistors in a dry oven at 130 C for 240 h. Immediately after this exposure, place the resistors in an atmosphere of 66 C and 100% relative humidity for 125 h. Then take final resistance measurements and observe for erratic behavior. This cycle may be repeated, depending on the severity of the intended application.

Testing under load

The testing thus far still does not assure long-life stability under load conditions. An actual load-life test is needed.

Do this test at an ambient temperature of 70 C, with the resistor leads soldered to lightweight terminals. Bolt the clamps of metal-clad resistors to 4-in.-square steel plates, 0.05 in. thick, one plate for each resistor. The length of each lead should be about 1 in.

Arrange the resistors so heat from any one resistor doesn’t influence the temperature of any other. And allow only the natural convection circulation of air to cool the resistors. Use RCWV.

Expose the resistors to the 70-C ambient temperature without load for 2 h, then make the initial resistance measurements. Apply dc RCWV.
Table 4. Temperature cycling test sequence

<table>
<thead>
<tr>
<th>Step</th>
<th>Temperature °C</th>
<th>Time minutes</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>-55 ± 0</td>
<td>30</td>
</tr>
<tr>
<td>2</td>
<td>+25 ± 5</td>
<td>10</td>
</tr>
<tr>
<td>3</td>
<td>+85 ± 0</td>
<td>30</td>
</tr>
<tr>
<td>4</td>
<td>+25 ± 5</td>
<td>10</td>
</tr>
</tbody>
</table>

*Intermittently—1-1/2 h ON and 1/2 h OFF—for a total of 1000 h. Take resistance measurements near the end of OFF periods after 50, 100, 250, 500, 750 and 1000 h. Keep the resistor ambient temperature at 70 °C throughout.

For intermittent short-time overload testing, apply for 5 s a well-regulated dc or sine-wave voltage that is 2.5 times the RCWV but does not exceed the limit values in Table 1. Measure the resistance before and about 30 min after application of the test voltage.

For circuit applications that experience repeated pulses with peak values in excess of steady-state ratings, design special tests. These should last ideally for at least 1000 h under conditions that accurately represent the peak value, pulse waveform, repetition rate and environmental conditions that must be met. Even more severe conditions than expected are recommended to establish safety factors.

However, a good way to test easily for pulse capabilities is to use a capacitor-discharge technique for the stress signals. Charge a noninductive capacitor at successively higher voltages and discharge it through the resistor. The circuit should have a minimum and consistent inductance value. Make resistance measurements initially and after each capacitor discharge.

Some recommended test levels are listed in Table 5. Resistors are subjected to a single energy pulse from a capacitor discharge. The resistor samples should have a nominal resistance of at least 150 Ω. A change in resistance of more than 4% is considered excessive. The actual applied voltage can be computed from the equation

\[ V = \sqrt{\frac{2E}{C}} \]

where \( C \) = capacitance in farads and \( E \) = energy in watt-seconds (Table 5).

A resistor may be accurate, stable, resist moisture and take the stress of overloads, but if its leads break off easily or its resistance changes when the leads are stressed, the component is obviously too unreliable to be put to use.

To test lead strength, measure the initial resistance and then hold the resistor by one lead and gradually apply a pulling force of 5 lb to the other lead along the longitudinal axis of the resistor. Maintain the force for 5 s. For 1/8-W resistors, use only 2 lb. The leads, of course, should not come off.

Follow this pull test with a bend test. Bend the leads 90 degrees at a point 1/4 in. from the resistor body in a radius of about 1/32 in. (Fig. 2a). Then clamp the free end of the lead up to 3/64-in. from the bend (Fig. 2b).

Now rotate the resistor body 360 degrees about its longitudinal axis in alternating directions three times. Each rotation should be done in about 5 s. After the last rotation, measure the resistance—assuming, of course, that the lead has not broken off. The resistance should not have changed appreciably.

Solder heat is another stress that resistors must withstand. Measure initial resistance, then immerse the resistor leads, one at a time, for about 3 s each in molten solder at 350 °C (250 °C for 1/8-W resistors). Immerse to a distance of 1/8 to 3/16 in. from the resistor body. Now measure the final resistance about 24 h after the immersions; it should not exceed the manufacturer's specified limits.

Leads must be solderable

To evaluate solderability, use either a heated still pot or a recirculating-flow soldering machine, both capable of maintaining the solder at a uniform temperature of 232 °C. If a still pot is used, the stirring-paddle and skimmer material should not contaminate the solder.

The flux must consist of a minimum of 35% by weight of waterwhite rosin dissolved in 99% isopropyl alcohol. The solder should be 60% tin and 40% lead.

Test both leads of each resistor "as received," with normal care taken to prevent contamina-

Table 5. Capacitor energy-pulse test limits

<table>
<thead>
<tr>
<th>Rated wattage</th>
<th>Energy watt-seconds</th>
<th>Approx applied dc volts</th>
<th>Capacitance µF</th>
</tr>
</thead>
<tbody>
<tr>
<td>1/8</td>
<td>0.45</td>
<td>670</td>
<td>2</td>
</tr>
<tr>
<td>1/4</td>
<td>1.8</td>
<td>600</td>
<td>10</td>
</tr>
<tr>
<td>1/2</td>
<td>6.4</td>
<td>630</td>
<td>32</td>
</tr>
<tr>
<td>1</td>
<td>16.0</td>
<td>1000</td>
<td>32</td>
</tr>
<tr>
<td>2</td>
<td>44.0</td>
<td>1650</td>
<td>32</td>
</tr>
</tbody>
</table>
2. To test the twist strength of the terminal leads, first bend the leads (a), and then twist slowly three times for 360 degrees in alternate directions (b).

3. The resistors should be subjected to a vibration test over the frequency range and vibration amplitudes as shown in this graph.

The resistors should be subjected to a vibration test over the frequency range and vibration amplitudes as shown in this graph.

Shock and vibration testing

In addition to pull and bend stresses, resistors must contend with vibration and shock. To test for shock effects, mount them on rigid holding fixtures. Resistor leads should be supported 1/4 in. from the resistor body. Test leads to the resistors must be 22 AWG or smaller. Apply a sawtooth shock with a peak value of 100 g and duration of 6 ms. The actual velocity change must be within 10% of the ideal change of 9.7 ft/s.

Measure the initial resistance. Then subject the mounted resistors to 10 impacts in two directions: parallel and perpendicular to the longitudinal axis of the resistor. Provide electrical monitoring during the test to detect resistor discontinuities of 0.1 ms or greater. After the shock cycle make final measurements and examine for mechanical failures.

To evaluate vibration characteristics, the test fixtures with the resistors mounted on them must be free of mechanical resonances over the frequency range of 10 to 2000 Hz.

After measuring the initial resistance, subject the mounted resistors to the vibration amplitude and frequency range shown in Fig. 3. The vibration waveform should be a simpler harmonic motion with an amplitude that provides 20 g of peak acceleration but does not exceed 0.06-in. peak-to-peak displacement.

Vary the frequency approximately logarithmically between 10 and 2000 Hz with a return sweep to 10 Hz. The entire sweep cycle should be traversed in approximately 20 min. Continue this sweep cycle for 6 h in two directions—parallel and perpendicular to the longitudinal axis of the resistor. Test interruptions are permitted, provided the requirements for rate of change and total test duration are met.

Here again, provide electrical monitoring to detect resistor discontinuities of 0.1 ms or greater. Make the final measurements and examinations for mechanical failures after the tests.

Resistors must resist solvents

To test for the actions of common solvents, inspect the resistors visually first for color coding. This is so comparison can be with after-test results should the solvents remove the codes. In addition measure the initial resistance values at ambient room temperature. Then heat the resistors in an oven at 120 C for 4 h.

Immediately thereafter immerse the resistors completely in ultrasonically (25 kHz) agitated liquids at approximately 40 C, one solution at a time, in this order:

1. Methyl chloroform 10 min.
2. A 50-50 mixture of isopropyl alcohol and freon alcohol 5 min.
3. Toluene or xylene 30 min.
4. Trichloroethylene 30 min.
5. Tap water 30 min.

Avoid mechanical abrasion during the tests. At the conclusion of the immersions, allow the resistors to dry for 4 h. Then measure resistance values and examine the color code for changes.

Because of the popularity of Freon TMC, many manufacturers test resistors with a one minute immersion in this solvent. However a separate test group of resistors should be used for this or any other special solvents the resistors may be subjected to.
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Information Retrieval Number 120
Choosing the best enclosure: Here are do's and don'ts for putting equipment in a sturdy, eye-catching, low-cost package.

Selecting the right cabinet or rack for an instrument or circuit calls for a dual personality—well, almost. To do the job right, you must be both design engineer and purchasing agent. You must analyze the cabinet or rack construction from the standpoints of size, material, eye appeal and cost.

As a design engineer, you want the enclosure that best fits the equipment while providing good user efficiency. On the other hand, as a purchasing agent, you must watch out for expensive custom options; you want the best unit for the lowest possible cost.

If you can't find an enclosure that fits the equipment, consider minor equipment changes instead of custom cases. Depending on the number of enclosures needed, it might pay to redesign a portion of the circuit rather than buy a custom case.

Here are some do's and don'ts that can help minimize cost and simplify selection of the right enclosure. The list contains many often-overlooked design details. After checking these, you'll probably come up with several more of your own.

**Eye appeal**

**Do's**

1. Consult with the vendor when it comes to finishing or coloring the enclosure. It's important to know the environment the equipment will be operated in so the proper primer can be chosen to resist corrosion. For color selection, use Federal Color Chart No. 595. The lowest-cost colorings are "self-texturing" enamels, in which the resins are ground into the vehicle. To cut costs, use the vendor's standard paint whenever possible.

2. Decide how much "sophistication" you want in cabinet or rack styling. If you know the final location of the product—executive office, showroom, computer room, laboratory, production area, etc.—consider that factor.

3. Look through vendors' catalogs to see what is available from stock. Nearly every stock unit can be modified, for a price.

**Don'ts**

1. Try not to specify paint by brand name, unless the vendor can't supply an equivalent covering. Remember, air-dry paints (except lacquers) require dust-free rooms. Also, baking cycles change, depending upon oven type and paint formula. If you order a specific paint, you'll be responsible for the results—good or bad. Don't order a textured paint and then use silk-screening for lettering; the resulting resolution is very poor.

2. Avoid loading up the enclosure with fancy trim, two-tone paint, odd shapes, etc. You pay extra for these.

3. Don't purchase a completely painted unit and then modify it by punching holes, drilling, etc. Any operations like these will probably destroy the finish.
Mechanical extras

Do's
1. If slides are needed, tell the vendor the load to be moved, distance of travel and whether a tilting or disconnect feature is required. G forces should also be indicated for internal components.
2. Indicate panel size and the amount of air to be moved per minute if you plan to cool equipment with a blower. For casters, indicate load. Other accessories, such as drawers, handles, shelves, brackets, etc., are usually available in company catalogs.
3. For large room-like enclosures, try using aluminum extrusions with corner connectors. The engineering and fabricating costs are less than for similar steel structures, and the weight is up to 65% less, too.

Don'ts
1. Don't specify the slide loosely. If you aren't sure what type to use, explain the conditions and constraints to the vendor's applications engineering staff. Let the vendor help you select the slide.
2. Avoid constraining the vendor unnecessarily with tight noise-level and motor-shielding specifics. Check with the vendor for his specs on acoustic noise and his standard for shielded blowers and fans—he might be able to do the job at lower cost.
3. Minimize the use of aluminum extrusions, unless the vendor is extremely familiar with this construction method. The extrusions are trickier to use than steel, and they won't bear as much weight.

The inside specs

Do's
1. Allow an internal radius equal to the thickness of the material used.
2. Understand that sheared edges are not perfect but are generally accepted "as is" for materials up to 3/16-in. thick. Indicate areas where additional finishing is needed.
3. Allow for burrs on cut edges, unless special dies and punches are used for each metal thickness.
4. Specify in detail the amount of visible welding you can accept. Use such phrases as (a) "Remove weld marks completely;" (b) "Weld marks to be not over ±0.005-in. deep," and (c) "Weld marks not to be visible from 36-in. distance."
5. Make your smoothness requirements as minimal as possible. A 30-to-60-microinch finish is usually adequate.
6. Outline the requirements for mechanical loads, g forces, environment, etc. If heavy loads are expected, show their distribution.

Don'ts
1. Avoid specifying formed radii, unless they are actually needed.
2. Don't use the phrase "sheared edges not acceptable," unless this is absolutely necessary. And then use the wording only for material thicker than 1/8 in.
3. Try not to demand a general requirement like "debur all over," since this involves finishing both sides and is expensive.
4. Avoid MIL specs and certified welding, unless they are true requirements, since these procedures add substantially to the cost. Omit general terms like "no visible weld marks are permitted."
5. Try not to make rigid demands for surface "roughness," since textured finishes usually cover blemishes.
6. Don't forget to indicate which loading factors are important. Anti-tilt devices or provisions for bolting the unit to a floor or rack may be required.

(continued on page 102)
The outside specs

Do's
1. Outline in general terms the purpose of the enclosure and the approximate quantity needed.
2. Make a simple sketch to indicate physical dimensions (allow a tolerance of ±2 in. on height, width and depth, so you can use a low-cost standard case).
3. Indicate the placement of brackets, holes, cutouts, louvres, etc., together with acceptable tolerances.
4. Specify the material as loosely as possible and the range of gauges for various sections of the enclosure. Have the vendor indicate the alloys he intends to use, subject to your final approval. Specify exact alloys only if stresses, strains or other considerations require their use.
5. Use fractional tolerances when expressing dimensions, especially when measured from a formed edge.

Don'ts
1. Try not to make the enclosure design too elaborate or detailed, until you are familiar with the production capability of the vendor.
2. Avoid specifications that are so tight that they make it difficult for the vendor to quote on a standard product. The savings of standard vs custom designs can often be 10:1.
3. Don't specify hole tolerances for fasteners or louvres, unless absolutely necessary. Remember, practical tolerances vary with the thickness of the materials used.
4. Minimize the use of specific aluminum alloys. Vendors usually have thousands of pounds of material that they have purchased in volume at low prices. A small-quantity purchase of a specific alloy can increase cost substantially.
5. Try not to use two or three-place decimal dimensions from formed edges or between spot welds or tack welds. And don't make the tolerances from hole to hole tighter than the tolerance for the hole sizes themselves.

Available standards

Do's
1. Use EIA* specs, like RS-310-B, for racks, panels and other enclosures. These specs are for metric as well as English units. For large-quantity orders, it's less expensive to use tapped screw holes than threaded-screw receptacles.
2. Minimize the use of NEMA** standards. They apply more to electrical than electronic equipment.

Don'ts
1. Avoid the use of tolerances other than those listed in EIA standards, unless you are prepared to pay extra. The EIA standards have replaced RETMA* standards and Western Electric spacing.**
2. Don't confuse the different NEMA enclosure specifications. There are many different types and tradeoffs. For instance, don't use an expensive NEMA Type 4 case to meet the hose-test requirements in definition IC-1.2.68; all you really might need is the lower-cost Type 1 enclosure.

*EIA: Electronic Industries Association, 2001 Eye St., Washington, DC 20006.
**NEMA: National Electrical Manufacturers Association, 155 E. 44th St., New York, NY 10017.
*Radio Electronics and Television Manufacturers Association (original name of EIA).
**Western Electric spacing is the same as the EIA "Wide Mounting-Hole Spacing for Racks and Cabinets" specification.
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Now there's an alternative — Amphenol. You can't get better SMA connectors than Amphenol's. Ours operate at all microwave frequencies up to 25 GHz. RF performance and mechanical integrity comply with MIL-C-39012. They're easy to assemble with either crimp or solder connections. And our quality will give you a change of heart: all shell and body parts are gold-plated stainless steel. The center contact is gold-plated beryllium-copper. The dielectric is solid TFE, making Amphenol SMA's completely interchangeable with your present source.

Our price will make you want to change partners. When you hear our price, you'll know our SMA's are the best value around. So ask for a quote.

There's a big selection of popular types. Including styles for cable mounting, flange and bulkhead mounting, and stripline mounting. We also offer between-series adapters.

And our SMA's are available. Wherever you are. Your Amphenol Industrial Distributor can fix you up with the SMA connectors you need, by giving you fast off-the-shelf service. He's close to you (there are over sixty Amphenol Industrial Distributors — nationwide). Give him a ring (on the phone, not the finger). Or for more information, write or call us: Amphenol RF Division, 33 East Franklin Street, Danbury, Connecticut 06810. (203) 743-9272.

When you can connect it and forget it...that's quality.

AMPHENOL
Wrapping and un­wring tools are easily made from tubing

Inexpensive manual wire-wrapping and un­wring tools that do a professional job can be constructed from small-diameter nickel, alumi­num or brass tubing available at most hobby shops. The tubing costs approximately $0.25 for a 12-in. length. Tubing with ODs of 1/16, 3/32, 1/8, 5/32 and 3/16 in., cut into 2-in. lengths, is used. Epoxy the 1/8 tubing inside the 5/32 tubing, and then fasten both inside the 3/16 tubing to form a handle. Make two such handles.

To form the wire-wrapping stem, apply epoxy to a length of 1/16 tubing, insert it into 3/32 tubing and carefully crimp one end of only the 3/32 tubing until there is a noticeable gap be­tween the two tubes. Make the crimp about 3 16-in. long. Select a drill bit about the size of the wire you intend to wrap—a 0.020-in. drill is suitable for 30-AWG wire.

First, drill a hole through only the 3/32 tubing at right angles to the stem at the back of the crimp, and then drill a hole through the gap to­ward the previously drilled hole (see figure). With a file, shape the tubing at the drilled back of the crimp so a wire inserted from the front slides easily out the back. Finally epoxy 1 in. of the stem inside the handle and allow sufficient curing time before use.

The unwrapping tool is made to remove right­handed wire wrapping. One end of 1/16 tubing is filed to approximately a 45-degree slope. Position the tube with the slope to your right and face it upwards. On the side of the tubing closest to you, at mid-point of the slope and perpendic­ular to it, file a notch half way through the slope and form a counterclockwise groove that winds part way around the tubing. The groove depth should cut partially through the tubing at the start and taper off as it lengthens.

Epoxy 1-1/2 in. of the square end of this 1/16 tubing into 3/32 tubing and 1-1/2 in. of the 3/32 tubing into the handle, and allow sufficient curing time before use.

With constant use, the tools wear. However, the faces of the tool can be reformed—about five minutes' work with a file. At least for the 1/16 and 3/32-in. tubing, nickel should be used, because it is harder than brass or aluminum.

David L. Holmes, Systems Engineer, Communications Electronics Div DOKS, Hq. Strategic Air Command, Offutt AFB, NE 68113.

CIRCLE NO. 311
There's now a new energy source that's a superb alternative: Rechargeable, sealed lead-acid batteries from Gates.

We call these batteries the future in energy cells. And for good reason.

They have all the product advantages you need plus economic advantages that may well give a new dimension to your product pricing.

Advantages: Gates Energy Cells are as compact as nickel cadmium or gelled type cells. And they are completely sealed, so that no acid vapor can leak out (they also include a self-sealing vent for extra safety). Gates Energy Cells provide low internal impedance for high discharge rates (more than 100 amps from the D cell and 200 amps from our X cell for short periods of time). And can be operated or stored in any position.

Gates Energy Cells offer great packaging flexibility. In fact, our individual cell availability allows you to choose your own specific voltage (in 2-volt increments) and current, as well as configuration.

Just as important as what Gates Energy Cells have to offer is what they don't have to offer. Like outgassing problems. Or cell reversal. Or "memory" problems.

Because Gates Energy Cells are made from low-cost materials that are readily available, they're very high in watt-hr. per dollar value. Which means that if you specify them, you'll probably save your company more than a few dollars. And make yourself into something of a hero in the bargain.

To find out more about the future in energy cells, circle our reader service number or write us. We'll send you free literature containing features, application information, ratings and specifications. George Sahl, Gates Energy Products, Inc., 1050 S. Broadway, Denver, CO 80217.
Programmable sawtooth generator settable at high and low output levels

Many circuits can generate sawtooth waves, but seldom can they be programmed easily to provide a wave that oscillates between two desired voltages—$V_L$, the higher voltage, and $V_H$, the lower voltage.

The circuit in Fig. 1 is programmed by voltages $V_{R_1}$ and $V_{R_2}$. It consists of an integrator, $IC_1$; a comparator, $IC_2$; and inverter, $IC_3$, and a switch, $IC_s$, where

$$V_U = V_{R_2} + V_{D3}$$
and

$$V_L = V_{R_1} - V_{D2}.$$  

Pin 3 of $IC_2$ is at $V_U$ during the rising portion of the waveform. Since pin 2 is at a much lower voltage than $V_U$, the output of $IC_2$ is $\approx V_{cc}$ (Fig. 2). This output is applied to pin 2 of $IC_s$. And with only $V_{R_1}$ on pin 3, the $IC_3$ output is approximately zero, which holds the switch, $IC_s$, open.

When the integrator output reaches $V_U$, the output of $IC_3$ changes to near 0 V, and its pin 3 drops to $V_L$. Then $IC_3$’s output goes to $V_{cc}$, which turns on the $IC_s$ switch to discharge $C_1$. When the integrator output falls to $V_L$, pin 6 of $IC_2$ goes back to approximately $V_{cc}$, the switch opens and the ramp part of the waveform is again generated.

The ramp rise time is given by

$$t_r = \frac{R_1C_1(V_U - V_L)}{V_{R_1} - V_{D1}}.$$  

The fall time, $t_f$, is determined by the slower of either the time constant of $C_1$ and the $IC_3$ switch resistance or the slewing-rate limit of $IC_1$, $IC_2$ or $IC_3$.

Since the $IC_2$ and $IC_3$ outputs are pulses with amplitudes that range from near zero to the power-supply voltage, these ICs should be fast. Thus 531s are used. Because in the author’s application the maximum required sawtooth excursion was only 1 V, the slower 741 was used for the integrator. In this circuit the fall time is about 2 $\mu$s.

The circuit can be synchronized with negative pulses to pin 2 of $IC_3$.

Jack E. Holzschuh, Project Engineer, Dept. of the Navy, Naval Undersea Center, Hawaii Laboratory, P.O. Box 997, Kailua, Hawaii 96734.

CIRCLE NO. 312
Cuts transformer weight, size and cost almost in half!

Special "split" bobbin (secondary wound alongside primary rather than over it) effectively isolates primary and secondary and reduces inter-winding capacitance. An electro-static shield is not required in all but the most sensitive applications. Hipot rating of 2500V RMS is standard. Bobbin winding technique affords a 40-50% savings in winding space over conventional layer winding. "Split" bobbin eliminates the need for inter-winding insulation and cross-over of primary and secondary leads.

Grain-oriented steel core is used at higher saturation flux densities and results in about a 40% reduction in turns required. Although the cost per lb. of grain-oriented steel is higher than that for ordinary silicon steels, the net cost is less, since less core weight is required and a significant reduction is made in copper weight.

Terminals, which are wedged into the bobbin wall, are designed so that they can be used as solder lugs or as 0.187" quick-connect types. Lead slots are incorporated in the bobbin wall leading to the terminals. It is not necessary to tape the start lead since it comes to the top of the coil through the slot and is thus separated from the winding. Separate lead wires or terminal boards and the extra assembly time to use them are eliminated.

Fresh thinking in engineering design and material selection has reduced material and labor cost and results in a series of small power transformers which cut weight, size, and cost almost in half. Therefore, we named them the "2-for-1" series...

-and Signal has it in Stock!

Signal transformer co., inc.
1 Junius Street, Brooklyn, N.Y. 11212
Tel: (212) 498-5111 • Telex 12-5709
Power-failure alarm operates a long time on a single 1.5-V cell

A power-failure alert is often a vital need, especially in hospitals and laboratories. The warning circuit shown drains only about 50 µA from a single-cell battery when the ac power is normal. This low drain allows more than a three-year life from many battery types.

Capacitor C, and resistor R, form a positive-feedback loop to make an LM3909 oscillate. However, with ac line power, charge accumulates on C, to keep pin 8 slightly more positive than pin 2. This cuts off the input transistor of the LM3909 and the complementary, direct-coupled circuit of the IC almost completely turns off.

When line power fails long enough to allow the charge on C, to disappear and reverse its polarity somewhat, the IC oscillates. The very small reverse voltage on C, and the short time that it is reversed cause no damage to C, even if it is electrolytic.

Current from the line charges only the capacitor and produces very little flow in the 1.5-V cell. The circuit is safe to leave plugged-in for years.

The alarm tends to oscillate at the speaker’s self-resonant frequency. A louder and clearer tone results if the speaker enclosure is built to augment the speaker resonance. This can be done by adjustment of the enclosure size with baffles and ports.

Peter Lefferts, Design Engineer, MS 220, National Semiconductor Corp., 2900 Semiconductor Dr., Santa Clara, CA 95051. CIRCLE No. 313

---

IFD Winner of July 5, 1975

Robert W. Hilsher, Assistant Engineer, Dept. 487, Bendix Communications Div., E. Joppa Rd., Baltimore, MD 21204. His idea “Constant Period with Variable Duty Cycle Obtained from 555 Timer with Single Control” has been voted the Most Valuable of Issue Award.

Vote for the Best Idea in this issue by circling the number for your selection on the Information Retrieval Card at the back of this issue.

SEND US YOUR IDEAS FOR DESIGN. You may win a grand total of $1050 (cash)! Here’s how. Submit your IFD describing a new or important circuit or design technique, the clever use of a new component or test equipment, packaging tips, cost-saving ideas to our Ideas for Design editor. Ideas can only be considered for publication if they are submitted exclusively to ELECTRONIC DESIGN. You will receive $20 for each published idea. $30 more if it is voted best of issue by our readers. The best-of-issue winners become eligible for the Idea of the Year award of $1000.

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The very latest state-of-the-art technology combined with exhaustive qualification testing guarantees the quality and reliability of Solitron chips. For example, our dice are 100% tested to meet the rating of the die either in chip or wafer form. Dice can be packaged for shipment either in bulk form or in cavity packs. Flat packs are used for complete wafers. Shipments in hermetically sealed containers may be requested.

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PLANTS IN: CALIFORNIA • FLORIDA • NEW YORK • ENGLAND • HONG KONG • MEXICO
Ratio ratemeter has high accuracy

A ratio ratemeter that is accurate to better than 1% with regularly distributed input pulses and 2% with statistically averaged pulses has been designed by the Radiation Centre, University of Birmingham, England. The output of the circuit (see figure) is proportional to \( N_1/N_2 \), where \( N_1 \) and \( N_2 \) are average rates of the applied input pulse trains.

The ratemeter consists of a logic circuit and an integrator. The logic circuit converts the two input trains into a single train whose pulse rate is equal to \( N_1 \). The pulse width is equal to the time intervals between two adjacent pulses in the \( N_2 \) train.

Operation of the ratio ratemeter is satisfactory as long as at least two \( N_2 \) pulses appear for every time interval, or the gap between two successive pulses \( N_1 \). For regularly distributed input pulses, it is sufficient to satisfy the following conditions: \( 2N_1 < N_2 \). For random pulse trains, \( 2N \) should be much less than \( N_2 \).

Heartbeat drives pacemaker signal

A pacemaker that uses a delayed, amplified signal generated by the patient's own heartbeat—conventional pacemakers are driven by a pulse generator—has been developed at the Royal County Hospital in Brighton and Sussex University's Medical Research Centre, England.

The new device picks up an electrical pulse produced when the atrium—the chamber above a ventricle—contracts to fill the ventricle prior to its contraction. The unit delays the atrial pulse for the proper fraction of a second and uses this signal, amplified, as the stimulus for the ventricle. If the ventricular beat fails, a fail-safe pulse generator takes over.

This technique has two advantages. First, the ventricle contracts at the correct time after the atrium has filled it. And, second, because the atrial beat adjusts to the body's needs, the pacemaker is physiologically compatible.

The pacemaker's catheter, which picks up the signals from the atrium, also picks up a signal from the ventricle but electronically screens this out, preventing the much greater electrical activity of the ventricle from confusing the pacemaker.

Cambridge Instruments, Cambridge, England, is currently building five nonimplantable commercial models for further hospital trials. The research team at Sussex is miniaturizing the electronic package and battery so it can be implanted.

Road-guidance system directs by minicomputer

An automatic highway guidance system, known as ALI, provides information on directions, weather ahead and traffic. Developed by Blaupunke Werke GmbH of West Germany, the system also indicates the best speed to make the fastest time.

Each car in the system has a radio transceiver with a 20-cm ferrite antenna. An indicator panel conveys information to the driver, who keys in a four-character code that represents his destination. The first character defines one of 16 zones in Germany; the second, one of 16 areas within each zone; and the remaining two, an area about three square miles. Resolution is sufficient to direct the driver to within 1.5 miles of 65,000 destinations.

Messages from the system's minicomputers are preceded by a series of rapid flags to draw the driver's attention. An analog scale indicates changes of direction. Communication to roadside beacons is performed by buried inductance loops.
There's a reason we make so many types of precision resistors. You need them.

Established Reliability Metal Glaze. Per MIL-R-39017, 55182 and program specifications.

Precision Metal Glaze™. Rugged performance at low cost. An industry standard for semiprecision and precision film resistor applications.

Precision Metal Film. Excellent high stability performance in a wide variety of sizes and specs. S level MIL-R-55182.

Precision Power Wirewound. Best available power-to-size ratio from ½-10W. Tolerances to 0.1%, TC < 20ppm.

Precision High Voltage, High Resistance Metal Film. Excellent high voltage load stability; 1.5-20KV, to 500 Megohms ± 1%.

Ultra-Precision MAR™. Bulk property metal film. Rugged molded construction. Broad resistance range, high frequency response with TC's and tolerances to 2ppm and .01%.

Precision Power Metal Glaze. 3W rating in a molded RW69 size. Runs cooler than wirewound. Has excellent frequency characteristics.

Precision Power Metal Film. Excellent power-to-size ratio. 1-5W ratings. High frequency response. Tolerances and TC's to 0.1%, 25ppm.

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Most types available from your local distributor. Or, for the broadest choice in resistors for all types of applications, write or call TRW/IRC Resistors, an Electronic Components Division of TRW, Inc., 401 N. Broad St., Phila., Pa. 19108. Tel. 215-922-8900.

TRW® IRC RESISTORS
We give you a choice.
TI’s New TMS 4051
The fully TTL compatible 4K RAM in the 18-pin space saver package

Available now in the 18-pin space-saver package: A fully TTL compatible 4K RAM. In addition to the high board density achievable with the compact 18-pin package, board space is also minimized because the TMS 4051 is fully TTL compatible and fewer parts are necessary. Fewer parts, less wiring, and a smaller PC board mean the TMS 4051 will save you money.

Easiest 4K dynamic RAM to use. The TMS 4051 is fully compatible and will plug directly into your Series 74 TTL system. No longer is a high voltage clock driver needed to interface from TTL to MOS. All TMS 4051 inputs (including the single clock) and output interface directly with TTL.

Reduce parts. Save PC board space. In addition to eliminating the need for clock driver ICs, the TMS 4051 requires no external address multiplexers or address registers. The on-chip address registers provide full direct addressing eliminating system timing headaches. The TMS 4051’s common data I/O eliminates the need for an external I/O multiplexer making it ideal for bus-oriented and microprocessor based systems. And the space saver package alone yields as much as 30% board savings over 22-pin 4K RAMs.

Availability is now.
TMS 4051 adds to TI’s pioneering experience and volume production of 4K RAMs. TMS 4051 uses the same proven single transistor cell design as TI’s popular TMS 4030 and 4060. Result: High density. High yield. Lower cost to you. The TMS 4051 is available in 300 mil wide 18-pin plastic and ceramic packages.

Proven reliability.
The TMS 4051 uses TI’s reliable N-channel silicon gate process, the same as TI’s other RAMs. And TI has proven field reliability.

For a 24-page reliability report of TI’s 4K RAM family or a data sheet, write on your letterhead to: Texas Instruments Incorporated P.O. Box 5012, M/S 308, Dallas, Texas 75222.
Analyzer brings new power to network-behavior measurement


With the broadest frequency coverage, widest displayed dynamic range and a line-up of performance features hitherto unavailable, Hewlett-Packard's Model 8505A brings new measurement power to network analysis.

The HP unit measures magnitude and phase—from 500 kHz to 1.3 GHz—of the transmission and reflection properties of active and passive networks. And you can also use the analyzer to measure group delay and deviation from linear phase.

Three channels (two independent and one reference input)—each with 100-dB of dynamic range—let you display on a CRT, two parameters simultaneously, and you can see ratios over the full dynamic range without switching.

Either of two coordinate systems, rectilinear or polar, can be selected to view the input parameter as a function of frequency. Or you can display one parameter in rectilinear and the other in polar format.

Fully integrated, the 8505A contains a swept source, which can operate in several modes, a built-in counter for direct readout of frequency to the top frequency, and various digital displays of the measurement parameters.

Internal RAMs let you select independent operating conditions for the sweep, so that two, independent start-stop sweeps can be programmed. You can also set any of five independent markers, and the counter will measure the marker frequency while the unit is sweeping.

Other digital displays read magnitude, phase or delay at the marker setting with resolutions of 0.01 dB, 0.1° and 0.1 ns, respectively. The group delay and linear-phase deviation features are also fully calibrated and direct reading—no calculation is needed. Pushbuttons for each digit of display provide calibrated offsets (up or down) of the reference in steps as fine as the specified resolutions.

Linear phase is measured with an electronic line stretcher built into the HP analyzer (no cable lengths to jockey) and settable with pushbuttons up to almost five wavelengths.

Noteworthy is the ability to use the 8505A as a calculator based automatic network analyzer. In this application, the system (called the 8507A) offers an “accuracy enhancement program” which measures and stores system errors, then applies the information to the measured data to boost accuracy.

Another notable feature of the automatic system is a “learn” mode: Each 8505A control setting is read by the calculator and put into memory. Consequently, you don't need to know any programming language—you write” the program by just twirling the analyzer's dials and storing the settings.

Other popular analyzers cover a smaller frequency and dynamic range compared with the HP unit. And few analyzers include the sweep generator and frequency-marker capability in the same box. These are usually separate, add-on units. Included are HP’s own 8407A, the General Radio 1710 and the Rohde & Schwarz ZWD swept diagraph.

Price of the basic 8505A is $22,500. Another $2950 buys programmability through the HP-IB interface bus. Options include an S-parameter test set, a three-way power splitter, a transmission/reflection bridge and various calibration kits. Delivery of the Hewlett-Packard 8505A starts in January.

CIRCLE NO. 304
INSTRUMENTATION

Unit automatically makes white-noise tests

Marconi Instruments, 100 Stonehurst Ct., Northvale, NJ 07647. (201) 767-7250. $6900; 60 days.

Model 2090C white-noise test set provides an automatic measurement capability for all noise loading tests. The unit retains the accuracy of the company's manually operated 2090B and, in addition, has the automatic, programmable mode of operation and a digital readout. It conforms to the CCIR and Intelsat recommendations for white-noise testing, as well as current DCA and Bell standards. The 2-1/2-digit readout is presented as a front-panel display and shows the unit of the selected measurement function alongside its value. Outputs are also provided in both BCD and analog form for recording purposes.

CIRCLE NO. 306

Cassette recorder accepts four channels

Dallas Instruments, P.O. Box 38189, Dallas, TX 75238. (214) 341-2990. $3600; 4-6 wks.

Model T-5 portable magnetic tape recording system provides four channels of FM and direct signal record and playback. The system uses a tape cassette in the convenient Philips format and provides up to one-hour recording time. The deck has a digital tape counter and is pushbutton operated. The system has both record and reproduce electronics and covers the frequency range of dc to 1000 Hz in FM mode and 100 to 10,000 Hz in the direct mode of operation.

CIRCLE NO. 307
Smart timer/counter brings new benefits

Dana Laboratories, 2401 Campus Dr., Irvine, CA 92664. (714) 833-1234. 9015, $2995; 9035, $3495; 90 days.

Series 9000 microprocessing timer/counter is a standard timer/counter, a reciprocating counter and a calculator all in one package. Two models handle frequencies to 100 and 512 MHz, respectively. The instruments feature a calculator-type keyboard for function control, rather than traditional knobs, buttons or switches. The keyboard is located in a front-panel drawer and disappears from view when not in use. An 11-digit, 0.43-in. yellow LED display provides numeric information while LED lamps are used as status indicators. Interface options include a general purpose interface bus (GPIB) system, a parallel BCD format, a serial ASCII and a "do-it-yourself" high speed option. With another option, the 9000 calculates rise and fall times and pulse widths. Standard is automatic trigger. Or you can key in trigger levels for unusual waveforms. Stability is $3 \times 10^{-7}$ per month. Higher stability is optional.

CIRCLE NO. 308

Test system checks microprocessors

Instrumentation Engineering, 769 Susquehanna Ave., Franklin Lakes, NJ 07417. (201) 891-9300.

Model 103, system 300-series computer-controlled test system performs high-speed functional tests and fault diagnostics on microprocessors and other complex digital logic circuits on printed circuit boards. The system uses a two-family digital word general/receiver (DWG/R) that enables the user to test as many as four different levels of logic simultaneously. The DWG/R contains bidirectional pins so that it can test bidirectional busses on microprocessor PCBs in real time.

CIRCLE NO. 309

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SLIM-MOX

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QUALITY COSTS LESS
THAN A DOLLAR.

Victoreen announces SLIM-MOX, our new, thick-film, flat substrate resistor. Compact in design, it carries with it all the quality and dependable performance you have come to expect from Victoreen.

SLIM-MOX, right now, is available from stock in a wide range of standard resistance values. More important, SLIM-MOX will deliver the same proven performance in high-voltage applications that you find in more expensive resistors with more bulk.

Specify SLIM-MOX in any standard resistance value and your unit cost will be less than one dollar in OEM quantities.

Truly a major cost breakthrough for resistors designed for miniaturized electronic networks and equipment, or other critical applications that demand stability and reliability.

Standard tolerance is ± 15% for all standard resistance values which include 1, 2, 5, 10, 20, 50, 100, 200, 500, 1000, 2000, and 5000 megohm. All in stock. With a voltage coefficient of better than 5 ppm/volt, full-load drift typically less than 0.5% in 1000 hr at 70°C, and 250 ppm TCR or less to 5000 megohm, SLIM-MOX is a little, big performer. For less than a buck.

From a name you know you can count on, Victoreen.

Victoreen Instrument Division, Sheller-Globe Corporation, 10101 Woodland Avenue, Cleveland, Ohio 44104

SLIM-MOX SPECIFICATIONS

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CIRCLE NO. 398

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INFORMATION RETRIEVAL NUMBER 45
Computer series offers low cost, high performance


A series of four micro and mini-computers offers full 16-bit operation with the speed of MSI TTL processors but at the cost of 8-bit PMOS microprocessors. The General Automation GA-16 series provides an instruction execution time of less than 2 µs.

There are four units—the 110, 220, 330 and 440. The 110 and 220 are single and dual-board micro-computers that come with 1-k of solid-state RAM as standard. The board size is only 7.75 × 11 in., and the computers cost $531 and $765, respectively.

Capabilities of the 110 include 91 basic microprogrammed instructions, 16 general-purpose registers, memory expansion to 64-k words, 11 addressing modes. A complete set of arithmetic and logic instructions and auto restart capability are just some of the features.

The Model 220 includes all this and more—a microconsole ROM, TTY controller and serial I/O port and DMA capability of the larger SPC-16 series of minicomputers.

The other two units in the series, the 330 and 440, are housed in 5.25 × 19 × 21.25-in. and 8.75 × 19 × 21.25-in. rack-mounting cabinets, respectively. The 330 comes with 4-k of core memory and costs $1950, while the 440 equipped with 16-k costs $5370.

The 330 has no operator controls, save for the on-off switch, while the 440 has a full operator's console with keyboard and displays. Both computers can directly address 1 million words of memory, and they have a memory cycle time of 720 ns.

All of the software and I/O devices for General Automation's SPC-16 minicomputer line are directly compatible with the GA-16 series. This will save considerable time and effort in designing systems and getting them on-line. Prices for the GA-16 series machines are given for maximum-discount quantity purchases. Single unit prices are about 40% higher.

All four computers are based on a two-chip NMOS LSI processor developed by General Automation and a subsidiary, Synertek. The processor chips consist of a 16-bit register arithmetic and logic chip and a control read-only memory. Together they have a complexity of about 20,000 components.

CIRCLE NO. 305
Monolithic Systems Corp., 14 Inverness Drive East, Englewood, CO 80110. (303) 770-7400. $820 (unit qty); 4 wks.

A new 8-bit microcomputer, the MSC8080, includes a general-purpose wire-wrapappable section, which simplifies the task of interfacing the computer to a particular system. This single-board unit uses an Intel 8080 microprocessor and includes interfaces for input, output, optional memory and control panel. Room is provided for 1 k × 8 of PROM, and a number of pre-programmed PROMs are available as options. A power inverter on the board supplies all necessary processor voltage levels from a single +5-V input.

CIRCLE NO. 320

For High-Voltage, High-Current Interface with PMOS, CMOS, TTL, DTL... Sprague Darlington Transistor Arrays Have No Equal

A new exclusive Sprague development, Series 2000 Transistor Arrays are high-voltage, high-current integrated circuits comprised of seven silicon NPN Darlington pairs on a common monolithic substrate. They feature open collector outputs and integral suppression diodes for inductive loads.

Supplied in 16-pin dual in-line plastic, these devices greatly reduce the number of discrete components used to interface between digital logic and high-voltage and/or high-current loads. In some applications, all discrete components can be replaced by a single DIP, resulting in substantial space and cost reduction.

With broad commercial/industrial application, these unique arrays are an excellent choice for interfacing to LEDs, solenoids, relays, lamps, and small stepping motors in printing calculators, cash registers, and control equipment.

Type ULN-2001A is a general-purpose array, pinned with inputs opposite outputs to facilitate circuit board layout. Type ULN-2002A is designed for use with 14 to 25 V PMOS inputs. Type ULN-2003A interfaces with TTL or CMOS operating at a 5 V supply voltage.

For more information, write or call Chuck Scott, Semiconductor Division, Sprague Electric Co., 115 Northeast Cutoff, Worcester, Mass. 01606. Tel. 617/853-5008.


For the name of your nearest Sprague Semiconductor Distributor, write or call Roger Lemere, Sprague Products Company, North Adams, Mass. 01247. Tel. 413/664-4481.
Interface converts printer to data terminal

Bedford Computer Systems, Inc., Three Preston Court, Bedford, MA 01730. (617) 275-0870. $1125 (unit qty).

The Model 1200 printer control converts the Qume Q-30 or Diablo HyType-I printer mechanisms into low-cost receive-only data terminals. Options can augment the basic terminal into a stand-alone interactive keyboard-entry work station. The basic package includes a power supply with sufficient power for the printer; an interface module, which is contained in the power-supply assembly; and all required interface cables. The printer control operates in ASCII code with a full or half-duplex mode over an asynchronous serial RS-232 interface.

CIRCLE NO. 322

Microprocessor system uses 16-bit chips


The Series 1600 microprocessor system is based on a 16-bit microprocessor chip and built with GI's n-channel ion-implant Giant II process. The processor design uses eight 16-bit general-purpose registers. All registers are program-accessible and can be used as accumulators or address registers. Six of the registers can be used by the running program, one is used as the memory stack pointer and the eighth is used as the program counter. The memory stack pointer provides last-in, first-out storage in the main memory. The general registers and high-speed pipelined ALU and its status register form the data-processing logic for all series 1600 microprocessors. Compatible assembler/simulator software is available for popular minicomputer systems and large time-sharing machines. Comprehensive subroutine libraries, diagnostics, utility programs and an online debug program for direct program checkout of the 1600 system are also available.

CIRCLE NO. 323

Low-cost CRT terminal offers full features

KKM Corp., Micro Application Systems Div., Box 213, Grand Forks, ND 58201. (701) 772-5944. See text; 60 day.

The MAS/T1 CRT terminal is designed as a low-cost teletypewriter replacement. It costs only $649 in singles and can perform in many minicomputer applications where intelligence and other features are an unnecessary luxury. Standard features include full cursor control, character and line insertion/deletion, tab control, selectable speeds to 9600 baud, and solid/blanking underline cursor. The MAS/T1 display uses a 5 x 7 dot matrix and has a 12-line-by-80-character capacity on a 9-in. video display (24 by 80 capacity and 12-in. display are available options). RS-232 compatible output is standard. Other outputs or the ability to add on I/O devices (cassette, floppy disc, or printer) are available as options. The terminal can do a self-test, functioning in either online or local modes to indicate whether it is operational.

CIRCLE NO. 324

UV PROM eraser handles five devices at a time

Prometrics Inc., 5345 N. Kedzie Ave., Chicago, IL 60625. (312) 539-3373.

Up to five UV-erasable PROMs are erased in 5 to 10 min with complete safety to devices and personnel. An adjustable timer shuts off the UV source when the set-in time has elapsed. The unit's housing is designed to prevent UV leakage. An interlock shuts off the UV when unit is opened. Devices rated at 6 W/s/cm² integrated exposure, such as the 1702A/4702A, require less than 5 min for complete erasure; 10-W/s/cm² devices, such as the 2704 and 2708, erase in less than 10 min.

CIRCLE NO. 325
STABILITY YOU CAN COUNT ON...

MURATA'S TEMPERATURE COMPENSATING CERAMIC CAPACITORS.

- NPO TO N4700
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- FAST DELIVERIES
- RELIABILITY BACKED BY 30 YEARS OF EXPERIENCE

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Rockmart Industrial Park, Rockmart, Georgia 30153
Phone: 404-684-7143   Telex: 54-2999

INFORMATION RETRIEVAL NUMBER 49

Micro Networks MN5120 Series of successive approximation 8 Bit A/D converters is now less than half the cost of the previously available Dip A/D converters.

The outstanding features include:

- Completely Adjustment Free... no external components or trim pots required; just plug in.
- Linearity ...±1/2 LSB from 0 to 70°C, no TC specs needed.
- High Speed...6 μsec setting time.
- Low Power...680mw typical — a savings of 30 to 50% over modular units.
- Hermetic Sealed Dip...for long term stability.

The MN5120 Series of A/D converters with its high performance and low cost makes it ideal for commercial and industrial applications, typical of which are: medical instrumentation, process control, computer peripherals, and interface circuits. All units are 100% electrically tested at 0, 25, and 70°C for linearity and accuracy.

For complete data write or call — Jerry Flynn: Tel: 617 852-5400.

INFORMATION RETRIEVAL NUMBER 50

MINI-ROTARY SWITCHES

New ROTARY SWITCHES feature adjustable stops & are only 6/10” in diameter. Molded-in terminals prevent contamination. For PC or hand wired use. Available in one through 4 poles with 36° detent; waterproof types too! 10,000 operations @ rated .5 amps, 125 VAC load.

Call (617) 685-4371 for more detailed information.

INFORMATION RETRIEVAL NUMBER 52

8 bit A/D's now only $59.00

Electronics Design 23, November 8, 1975
Mini resistor chips offer the tops in accuracy and stability

Vishay Resistor Products, 63 Lincoln Hwy., Malvern, PA 19355. (215) 644-1300. See text.

Buy a chip resistor today and try to get another exactly like it next year. Vishay says you can do the improbable with its V50X50 Series of Microchip precision resistors.

These resistor chips are built with Vishay’s proprietary Bulk-Metal process that is said to permit accuracies and repeatabilities to within 0.01% and stabilities of 5 ppm/°C over the -55 to +150°C range. The chips measure only 50 × 50 × 15 mils and conform to or exceed all the requirements of MIL-R-55342A.

Resistance values ranging from 500 Ω to 5 kΩ are available, and chips with values from 1 Ω to 10 kΩ will be offered shortly. Power ratings for the chip start at 0.05 W at 70 C, when it is bonded to the ceramic substrate, and are rated to zero at 150 C.

Tracking of resistance values is to within 3 ppm over the full operating temperature range. End terminations of the resistor chips consist of gold plating over copper bonding pads and measure 6 × 6 mils. Each resistor chip has a moisture resistance of 0.5% ΔR, which improves to 0.005% ΔR under hermetic seal packaging conditions. Resistance shelf life is very long, with aging down to only 50 ppm/year.

Suggested termination for the chip is by thermal pulse welding of a 1-mil-diameter gold wire to the pads. The proprietary process used to form the resistors provides a form of stress control that counterbalances the temperature coefficient of the resistor element—thus keeping the value almost constant.

Two versions of the chip are available: a fully calibrated, finished chip made to exact user specifications and an uncalibrated chip for the user who can trim the chip to exact value before insertion or who must do active trimming after bonding. Fixtures and work stations will be available in the near future.

Prices for these tight-tolerance units start at $3 each in 100-piece lots for 1-to-2-kΩ values and $3.30 for 2-to-5-kΩ values. V50X50 resistor chips are available from 8 to 12 weeks for evaluation orders and 12 to 16 weeks for volume production.

**Chip capacitors resonant free to 10 GHz**

Johanson, Monolithic Dielectrics Div., Box 6456, Burbank, CA 91505. (213) 848-4465. $0.76 to $2.95 (1000 up); stock to 6 wks.

High-Q microwave ceramic chip capacitors with easy-to-mount ribbon leads offer resonance-free performance to 10 GHz. Chip sizes available are from 0.055 × 0.055 × 0.050-in. to 0.11 × 0.11 × 0.10-in, with a maximum capacity of 100 pF in the smallest size to 1000 pF in the largest.

**Pushbutton switches are illuminated**

Mechanical Enterprises, Inc., 8000 Forbes Pl., Springfield, VA 22151. (703) 321-8282. $0.60; T-5 (10,000 up)

Self-contained lights indicate keyboard switch action on sealed mercury M-5 and gold-plated contact T-5 pushbutton switch series. Clear plastic keytops, either box-shaped or truncated, contain a light diffuser made of thin polyester film that holds the switch legend. In large quantities, the legends are printed on the diffuser; for short runs, press-types can be used. The operator’s fingertips never contact the legends. Switches mount on 3/4-in. centers. T-1 bi-pin incandescent lamps are used to illuminate the switches. The plastic keytops snap off for bulb replacement.
Cermet film resistors meet MIL-R-39017


Allen-Bradley's Type CC cermet film fixed resistor MIL-Style RLR-07 has now been approved to MIL-R-39017 standards for resistance values from 10 Ω through 1 MΩ.

No other has been approved beyond 470 kΩ, A-B indicated. Six-week delivery time is being quoted for these resistors, compared with six to 13 weeks generally required for similar types. The resistors are offered in both 2% and 5% tolerances with a temperature coefficient of ±100 ppm/°C. The 1/4-W resistor measures 0.25-L × 0.09-D in. and is priced at 16 cents each in 1000-piece quantities. It is expected to be offered through A-B appointed electronic distributor locations this fall.

Chip capacitors meet MIL marking standard

American Technical Ceramics, One Norden Lane, Huntington Station, NY 11746. (516) 271-9600.

A new method of marking chip capacitors enables ATC to fully identify even its smallest micro-miniature rf chip capacitors—the ATC Case A, 55-mil cube—with the manufacturer's identification, capacity and tolerance code. Marking meets MIL-STD-202, Method 215 and is unaffected by all commonly used solvents and temperatures to 1500 F. ATC says it is the only capacitor manufacturer with such a marking capability. These marked rf chip capacitors are available in 40 different design values. Four kits contain Case A and Case B (110-mil cube) sizes with values ranging from 0.1 to 220 pF.
DISCRETE SEMICONDUCTORS

MOSFET analog switches made for ±5 and ±10 V

Signetics, 811 E. Arques Ave., Sunnyvale, CA 94086. (408) 739-7700. From $0.90 (100-up); stock.

Four D-MOS FET analog switches handle ±5 or ±10-V applications. The SD212 and SD213 are characterized for ±5-V analog switching or sample-and-hold. The SD214 and SD215 cover the same applications for ±10-V signals. The SD212 and SD214 do not have zener diode protection on the gates while the SD213 and SD215 do. All devices have an on-resistance of 35 Ω, typical. Input capacitance is 2 pF typically, output capacitance is 0.5 pF and feedback capacitance only 0.2 pF. Isolation from input to output is —120 dB typical at 3 kHz.

CIRCLE NO. 330

Power Darlington switches for inductive loads

Semicoa, 333 McCormick Ave., Costa Mesa, CA 92628. (714) 979-1900. From $18 (100-up); stock.

The SCA108 series of 10-A Darlington switches is designed for driving inductive loads. The transistors have a Vces of 100 V, a secondary breakdown of 5 A at 70 C (at rated BVces), an f of 60 MHz and leakage currents of less than 10 nA at 25 C. The Darlington has been tested from 10,000 to 70,000 minimum. An SCA108 will drive 20 mH at 2 A or 50 mH at 1 A. The SCA108 is available in an isolated or nonisolated TO-5 package for 25-W dissipation at 75 C, or in TO-3, TO-66 and TO-59 packages.

CIRCLE NO. 331

N-channel JFET has on resistance of 2.5 Ω

Teledyne Crystalonics, 147 Sherman St., Cambridge, MA 02140. (617) 491-1670. $13.40 (100-up); stock.

The 2N6568 silicon n-channel junction FET is designed for an ultra-low Rds. The FET ON resistance is specified as 2.5 Ω Rds. It also has extremely high isolation resistance of greater than 5 GΩ.

CIRCLE NO. 332

JAN power transistors handle up to 10 A


The JAN, JANTX and JANTS V-2N3715 silicon power transistors handle collector currents of up to 10 A. The transistors have collector voltage ratings of up to 80 V and are housed in TO-3 packages.

CIRCLE NO. 333

Epoxy transistors have 125-MHz gain-bandwidth

Sprague Electric, 347 Marshall St., North Adams, MA 01247. (413) 664-4411. $0.17 (large qty.); stock.

The NPSA20 Econoline transistor is housed in a TO-92 one-piece molded epoxy package. It has straight, in-line leads with an emitter-base-collector configuration. Power dissipation for the transistor is 560 mW. The collector-emitter voltage is 40 V maximum and the gain-bandwidth product is 125 MHz. Maximum collector current at 25 C is 100 mA. The maximum collector-emitter saturation voltage is only 0.25 V at a collector current of 10 mA.

CIRCLE NO. 334

Reverse switching diodes handle pulses to 1200 A


The T40R reverse switching rectifier is optimized for short, high rate-of-rise pulse switching. The two-terminal switching units are available with peak pulse current ratings up to 1200 A, current rate-of-rise ratings up to 2000 A/μs and blocking voltage range up to 1000 V at 125 C. A typical value of turn-off time is 100 μs at 25 C. The reverse switching rectifiers are available with repetitive peak forward blocking voltage ratings of 600, 800 or 1000 V. Maximum pulse trigger voltage—the off-state threshold voltage where turn-on begins when a 500-V/μs trigger pulse is applied—is 1500 V. The units are available in a DO-5 type stud-mounted package.

CIRCLE NO. 335
Berg's MINI-JUMP provides flexibility in the circuit programming of mini-computers, card readers, printers, modems, point-of-sale equipment and test instruments. It is designed for high-density packaging and is stackable in both directions on .100" centers and up. Low-profile design allows for tight packaging in the vertical plane. MINI-JUMP mates with industry standard .025" square or .028" round pins. (Note—.125, .150, 200 and .250 center versions will be available in the near future.) Write for Bulletin 144.

New Cumberland, Pa. 17070 Phone: (717) 938-6711

Berg's Quickie Connector simultaneously terminates multi-lead, flexible round conductor cable without pre-stripping. The askewed tines of the contact affect a stripping action which terminates virtually any insulation material in about 10 seconds. Design assures redundant electrical contact and allows for visual inspection before assembly. Connector can be supplied with either closed or open end-covers for Daisy Chain usage. The Right-Angle Quickie Header has a positive latch to assure continuous mating with low-contact resistance through vibration and impact. Quickie can be used to interface cable on .050" centers to .025" sq. wire-wrapping pins on .100" grid. Write for Catalog 131.

New Cumberland, Pa. 17070 Phone: (717) 938-6711
Multiplying d/a converters meet MIL specs at low cost


You can pay $200 or more for a multiplying digital-to-analog converter that meets military specs. But now there’s a lower cost alternative. The DAC-331, a 10-bit current-output hybrid microelectronic unit made by Hybrid Systems, costs only $49 in single quantities and is processed to MIL-STD-883, Level C, requirements.

The converter is designed to maintain accuracy over the entire military temperature range of −55 to +125 °C and is pin-compatible with the AD7520 made by Analog Devices (Norwood, MA).

There are two versions of the DAC-331, both with 10-bit resolution. The 331-8 has full-scale accuracy of ±0.3% over −25 to +85 °C, or ±0.5% over the full MIL range. The 331-10 has an accuracy of ±0.2% over −25 to +85 °C and ±0.4% over the full range. Either version can be processed to Level B or Level C of MIL-STD-883.

Analog output scaling is a nominal 40 μA/V. The reference input voltage can span a ±10-V range, and there is a feedthrough of 0.1% at 5 kHz, minimum. For a full-scale digital input change, the converters require only 2 μs to settle to within 0.05%.

Accuracy and stability errors are combined into a total spec. For the 331-8, these errors reach 0.2% of full-scale, while for the 331-10, they are only 0.1%. The output impedance is 25 kΩ.

The converters require only a single 3- to 10-V supply for operation and typically draw only 2.5 mA when operated at 5 V. Hermetically sealed ceramic 16-pin DIPs house the converters. These packages measure 0.75 × 0.3 × 0.1 in.

The AD7520, by comparison, is a monolithic CMOS multiplying d/a converter that costs $87 for a unit with 10-bit accuracy. Prices drop, though, to $42 if only 8-bit accuracy is needed. Both prices are for the MIL versions in unit qty. The gain tempo is 10 ppm/°C.

(continued on page 125)
Single unit prices for the DAC-331 series of converters start at $39 for the 351-8-MIL-C, 8-bit unit processed to 883 Level C and $49 for the 331-10-MIL-C, 10-bit converter also processed to Level C. Both converters are also available processed to 883 Level B with a price increase of approximately $15, depending upon test requirements. All units are available from stock to two weeks.

Hybrid Systems
Analog Devices
CIRCLE NO. 302
CIRCLE NO. 303

Rf amplifier in TO-8 covers 5 to 500 MHz
Aydin Vector, P.O. Box 328, Newtown, PA 18940. (215) 968-4371. $90 (1 to 9); stock to 2 wk.

The Model MHT-250 hybrid amplifier is housed in a 4-pin TO-8 package. It covers the frequency range of 5 to 500 MHz, has a noise figure of 2.5 dB, max, a power output of $-2$ dBm min., an input/output VSWR of 2:1 max and requires $+15$ V dc at 10 mA.

CIRCLE NO. 336

Counter/controller can retain count for 10 days

The Class 8854, Type PC-42 storage counter/controller runs from 120 V ac, 50 to 60 Hz. It consumes 15 VA and uses a rechargeable battery (charger included) to prevent loss of count. The battery will permit the unit to retain the count for 10 days if necessary. The unit uses CMOS circuitry, has an up/down reversible counter that counts between 0 and 15, an anticoincident circuit to allow simultaneous up and down counts and has a binary readout consisting of four LEDs in a 1248 code. The 10-A output relay switches when the chosen count is reached—de-energizing on count-up, energizing on count-down. The controller also has manual buttons to adjust the count up or down. The PC-42 is designed for heavy duty industrial applications and has a high electrical noise immunity. The PC-42 measures $8 \times 9.5 \times 4$ in. and is panel-mountable.

CIRCLE NO. 337

CUSTOM HYBRID MICROCIRCUITS

For Military/Aerospace Applications

CIRCUIT TECHNOLOGY INCORPORATED

160 Smith Street, Farmingdale, N.Y. 11735
Phone (516) 293-8686 • (213) 374-7446

INFORMATION RETRIEVAL NUMBER 61

SAM IS THE LOWEST PRICED READER YOU CAN BUY. BUT YOU DON'T GET SHORT CHANGED.

You could spend a lot more for a tape reader and still not get all of SAM’S quality features. SAM clips along at 300 cps. has our sure-footed dual sprocket drive and our state-of-the-art fiber optic light source and photo transistor read head. We can make SAM do all this and save you money because we do things differently.

The more you know about punched tape equipment, the better you read us.

This is the plain, brown wrapper SAM comes in.

250 CHANDLER STREET, WORCESTER, MASSACHUSETTS 01602, U.S.A. (617) 798-8731

INFORMATION RETRIEVAL NUMBER 62
Thirty years of designing and manufacturing cord sets, wire and cable has given us the kind of experience which can solve your problems. Whether you are stumped by a complex design requirement or a sticky cost situation, our engineering and production staffs can come up with the right answers. In fact, many of our now standard designs were created as solutions to specific customer problems. And, our reputation for ingenuity is equalled only by our reputation for quality.

Test us with your special requirements. You'll discover why Victor has become the standard of quality in cord sets and other wire specialty items.

Victor Electric Wire & Cable Corp.  
618 Main St., West Warwick, R.I. 02893  
Telephone: 401-821-1700  
TWX: 710-382-1534

INTEGRATED CIRCUITS

Preamp operates from 4-to-20-V supply

SGS-ATES Semiconductor, 435  
Newtonville Ave., Newtonville, MA 02160. (617) 969-1610. $1.60 (100-999); stock.

The TDA1054 preamp, packaged in a 16-pin DIP, operates from supply levels ranging from 4 to 20 V. The IC has a 0.5-dB noise figure, 110-dB open-loop gain and 0.1% distortion. Supply ripple rejection is 30 dB and automatic level-control range is 54 dB.

CIRCLE NO. 338

Voltage reference holds drift to 1 ppm/°C

National Semiconductor, 2900  
Semiconductor Dr., Santa Clara, CA 95051. (408) 732-5000. $3.25 to $35.00 (100); stock.

A monolithic temperature-stabilized voltage-reference IC outperforms standard zener diodes by a factor of 20. Called the LM199, the linear IC provides a 6.9-V reference and guarantees drift to be less than 1 ppm/°C. Long-term stability is better than 0.002%—the accuracy limit of the manufacturer's test system. Low-frequency noise is less than 10 μV, and the circuit requires only 300 mW at 25 C.

CIRCLE NO. 339

14-pin DIP holds wideband op amp

Optical Electronics Inc., P.O. Box 11140, Tucson, AZ 85734. (602) 624-8358. $36.50 (10-29); stock.

The Model 9916 op amp, packaged in a 14-pin DIP, features 150-MHz minimum guaranteed gain-bandwidth product, and 6-dB per octave uniform roll-off rate for high-frequency stability. It also has 60-dB open-loop gain at dc and ±300-V/μs minimum slew rate.

CIRCLE NO. 340
4-k 'CMOS' RAM accesses in 70 ns


The first 4096-bit RAM to employ both n and p-channel MOS devices—Toko's KM 8680—sets the pace for access and cycle times. The new silicon-gate dynamic RAM specs access at 70 ns typical and 100 ns maximum. Cycle time is 160 ns typical and 200 ns maximum.

Existing 4-k dynamic RAMs employ NMOS, and they have top access and cycle times of 200 and 400 ns, respectively.

The new "CMOS" memory employs n-channel single-transistor cells for the storage matrix, and it includes p-channel devices in the peripheral circuitry. Transistor gate lengths of 6 μ have been achieved, and the entire chip measures just 3.5 x 3.9 mm.

The new RAM has a maximum, total power dissipation of only 350 mW, compared with a watt or so for some NMOS versions. In the standby mode, the KM 8680 needs only 3 mW. Refresh is required every 2 ms.

The 4096 x 1-bit KM 8680 comes in a 22-pin ceramic DIP, with Intel and TI 4-k-RAM pinouts. It uses ±5 and 12-V supplies. However the 12-V supply can drop to as low as 5 V or rise as high as 16 V. So it's possible to have the memory operate, in fact, from just two supplies, +5 and −5 V.

Except for the chip-enable input, all input and output lines are TTL compatible.

Production quantities will be available in December. In sample quantities, the KM 8680 costs 6000 yen, or about $20. In quantities of 5000, unit prices drop to less than $14.

CIRCLE NO. 341

CMOS IC counts units or frequencies

Interstil, Inc., 10900 N. Tantau Ave., Cupertino, CA 95014. (408) 257-5450. $15.05 (100-999).

The ICM7208 CMOS circuit, a fully integrated counter-decoder-driver, can count units, frequencies or time intervals. It can directly drive a seven-decade multiplexed common-cathode LED display. The ICM7208 operates over a supply voltage range of 2 to 6 V. Its operating power dissipation is less than 10 mW; its quiescent power dissipation, less than 5 mW.

CIRCLE NO. 342

Interface inductive loads to TTL, MOS

Plessey Semiconductors, 1674 McGaw, Santa Ana, CA 92705. (714) 540-9979. $5.94 (100); stock.

Two bipolar devices provide a power interface between MOS and TTL devices and heavily resistive or inductive loads. The SP761B allows a direct 12-V MOS interface, while the SP762B permits a direct 5-V TTL interface. Both contain five current amplifiers, two of which include a common strobe input to control a high-current parallel output. The 12-V circuit delivers up to 150 mA with input current of approximately 3 mA. The 5-V circuit provides up to 200 mA with approximately 1 mA of input current. Both circuits can operate at speeds up to 1 MHz.

CIRCLE NO. 343

Multiply 16 x 16-bit numbers in 1 μs

Advanced Micro Devices, 901 Thompson Pl., Sunnyvale, CA 94086. (408) 732-2400. $23.25 (100).

With two Am25LS14 multipliers, a 16-bit by 16-bit multiplication can be accomplished in 1 μs. The new 8-bit circuit uses low-power Schottky techniques. The device takes an 8-bit multiplicand at its parallel X inputs and multiplies it by the multiplier that is clocked serially into the Y input. A two's-complement product is available at the serial output.

CIRCLE NO. 344

Laser marked UHF/Microwave chip capacitor kits

DESIGN VALUE KITS:

40 MARKED POPULAR VALUES IMMEDIATELY AVAILABLE IN KITS OR SEPARATELY.

BUY ANY DESIGN VALUE KIT OF 100 ATC 100 LOW-LOSS PORCELAIN CHIP CAPACITORS FOR $77.00.

Just circle the number below for more information on ATC's new laser marked chip capacitor kits.

american technical ceramics

CIRCLE NO. 345

ONE NORDEN LANE, HUNTINGTON STATION, N.Y. 11746 (516) 271-9600 • TWX 510-226-6993 INFORMATION RETRIEVAL NUMBER 64
Microwave substrate has high dielectric constant

3M Co., P.O. Box 33600, St. Paul, MN 55133. (612) 733-1725. For a 0.025-in.-thick sheet, $81 (1 to 4 sheets); stock.

The “Epsilam-10” microwave substrate, a high dielectric constant laminate for stripline or microstrip use has a dielectric constant of 10.3 ± 0.5. The copper clad, ceramic-filled Teflon compound combines the flexible mechanical properties of a plastic with electrical properties similar to alumina. Its high dielectric constant allows for reduced package size and weight and increased circuit density. Epsilam-10 is supplied in 9 x 9 in. sheets with a choice of thicknesses—0.025 or 0.05 in. with 1-oz copper on two sides. The sheet size allows for multiple circuit layout and processing using typical resists and etchants. The material can be easily machined, drilled, routed or cut with shears or knife.

Pawl latch locks out noise, dust & vibration

Rexnord Inc., Specialty Fastener Div., P.O. Box 98, Paramus, NJ 07652. (201) 845-6900. From $1.20 (1000-up); stock.

The Camloc 65L series pawl latch is designed to exert increasing pressure to hold gaskets to panels and access doors. One quarter turn locks the door and each additional turn pulls the door closer to the frame to apply the amount of latching pressure you need. The latch seals tightly to lock out noise, dust and vibration. Each latch suits many frame requirements of varying thicknesses with a grip range that compensates for wear and aging gaskets.

Processor hardware kit just needs the ICs

Pronetics Corp., P.O. Box 28582, Dallas, TX 75228. (214) 276-1968. $65 (1 to 99); 2 reks.

The PS-710 F-8 kit module is a fully assembled printed-circuit card with sockets to accept the F-8 microprocessor kit ICs. It can be used for prototype and development systems or as a standard hardware module for production systems. All necessary functions are available on a standard edge connector to permit memory expansion.
POWER SOURCES

Isolated supplies meet UL 544 specs


Two new power supply modules are UL approved for use in medical and dental instruments. Listed as a recognized component under UL 544, Model 7009 is rated at +5 V, 1000 mA and Model 7010 is rated at ±15 V, ±200 mA. Special bobbins and winding techniques provide complete physical isolation between primary and secondary windings. A.C. hot and neutral connections may be interchanged without any degradation of isolation. Isolation is specified as 10 pF of capacitance, 0.1-μA maximum leakage from input to output and a minimum voltage isolation rating of 5000 V.

CIRCLE NO. 356

Submodular supplies: 42 models, 7 packages

Power/Mate Corp., 514 S. River St., Hackensack, NJ 07601. (201) 343-6294. Start at $35.

By breaking a power supply into its submodular elements and then standardizing these elements, the company can offer custom power supplies economically and rapidly. The new SMS Series of submodular supplies consists of 42 different models in seven different package sizes. These provide a wide variety of voltages from 0 to 20.0 V and currents from 0 to 36.0 A. The series features built-in overvoltage protection, current limiting overload protection, and adjustable controls for voltage and other protective functions. Line and load regulation is better than 0.075% and the output ripple is better than 1 mV rms.

CIRCLE NO. 357

Open-frame source claims midget title

Power-One, 531 Dawson Dr., Camarillo, CA 93010. (805) 484-2806. $49.95; stock.

Said to be the world's smallest triple-output open-frame power supply, Model HTAA-16W provides 5 V at 2 A with OVP and ±9 to 15 V at 0.2 A. Total isolation between the 5 and ±9 to 15-V outputs allows the user to arrange polarities to suit his specific application. Size is 6.5 × 4 × 2.12 in. and weight is 2 lb. Standard features include 115/230 V ac ±10% input; ±0.05% line and load regulation, and full protection against short-circuit and overload. Maximum output ripple is 10 mV pk-pk while the full load operating temperature specifications are 0 to 50 C, derated to 71 C.

CIRCLE NO. 358

65 watts of reliable power in frequencies of 10 to 2500 MHz.

And here's what we built into our new 15122.

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- internal square wave modulation
- low tube cost/operating hour
- qualified to MIL-STD-461 and 810

It has six different plug-in heads

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<td>2000-2500</td>
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You have now ended your search for a stable, reliable 65 watt oscillator. Just call or write for detailed engineering data. Or ask for a demonstration.

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LaGrange, Illinois, 60525.
(312) 354-4350

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Digital multimeters
Portable, 3-1/2-digit multimeters are highlighted in a four-page bulletin. United Systems, Dayton, OH

CIRCLE NO. 359

Solid-state current sensor
Features, applications, absolute maximum ratings, electrical characteristics, mounting dimensions and operating characteristics of solid-state current sensors are listed in a four-page bulletin. Micro Switch, Freeport, IL

CIRCLE NO. 360

Structural foam

CIRCLE NO. 361

Chips and wafers
Specifications and data on wafer and chip processing, power ratings, testing, quality-assurance criteria, bonding and handling are given in a brochure. A guide cross-references standard packaged devices to chip types. Unitrode, Watertown, MA

CIRCLE NO. 362
GE’s June, 1975 miniature catalog has over 500 data changes that could affect your current design. Send for it. It’s free.

NEW. June ’75 Miniature Lamps: 40 pages. 500 changes. Data covers over 500 miniature lamps ranging up to 20,000 hours rated average life. With a design voltage range of from 1.2 to 55, and candle-power range from .02 to 250. Diameter range from 3/4" to 2 3/4".
Circle Product Card # 251

NEW. Feb. ’75 Sub-Miniature Lamps: 24 pages. 91 changes. Data covers over 210 sub-miniature lamps. Diameter’s 1/4" and smaller. Rated voltage 1.3 to 60. Candle-power range from 0.6 to 15. Rated average lamp life up to 60,000 hours.
Circle Product Card # 252

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CIRCLE NO. 363

Power supplies

Switching regulated power supplies are highlighted in a six-page foldout. Deltron, North Wales, PA

CIRCLE NO. 364

IC logic panels

A 20-page catalog covers IC logic panels. Interdyne, Van Nuys, CA

CIRCLE NO. 365

Resistors

Thin-film resistor networks including general-purpose networks, precision ladder networks, network starter kits and user designed chip and packaged network specifications are covered in a 16-page guide. Analog Devices, Norwood, MA

CIRCLE NO. 366

Microcomputer kits

Specification sheets cover six different ready-to-assemble microcomputer kits. Cramer Electronics, Newton, MA

CIRCLE NO. 367

Thick-film materials

Conductor cermet pastes, high temperature metalizing, dielectrics, resistor compositions, solder creams and protective coatings are covered in a 35-page catalog. Transene Co., Rowley, MA

CIRCLE NO. 368

Mini and microcomputers

The U-Series minicomputer and L-16A 16-bit microcomputer are covered in two separate catalogs. Background information on Panafacom is supplied in another catalog. Panafacom, Ltd., Jiyagoka, Meguro-ku, Tokyo, Japan.

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CIRCLE NO. 370

Siliconix has dropped prices by nearly one-third on its 3-1/2-digit LD110/LD111 a/d converter IC chip set and LD111/LD114 multiple-option a/d converter IC pair.

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The Monroe 324 scientific microcomputer has been reduced to $495.

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Signetics has announced that it will manufacture two device types selected from the Intel 3000 series as part of a bipolar microprocessor system set.

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New Band-Selectable Fourier Analysis (BSFA) software is now included in Hewlett-Packard's Model 5451B Fourier analyzer system.

CIRCLE NO. 373

National Semiconductor's Memory Systems group has begun volume production shipments of its MOS-RAM 410, featuring the MM2102 1k static memory chip.

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CIRCLE NO. 173

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computer/process interface

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Power Sources

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Mature, fully developed, and at their peak. It's our family of ceramic trimmers. All of them offer good stability, a variety of capacitance ranges, ceramic stators, linear tuning, and a precision rotor.

Our Micro-J Capacitor is the Cadillac of the group, and features high performance, monolithic design, and horizontal and vertical PC and stripline mounts.

Our Micro-K Capacitor is the newest member of the family. Tiny enough for quartz watches. And it has a precision lapped titanate stator and finely machined brass rotor.

Our 10mm model is low cost and mounts interchangeably with similar ceramic disc trimmers.

The 5mm type is even less expensive and can be used in the same applications as monolithic types where maximum stability isn't required.
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RCA high-voltage power transistors made our special way.

You already know RCA transistors for reliability and performance. But maybe you didn't know about our high-voltage, high-current, fast switching 2N6513, 2N6308 and 2N6251 families. Available off-the-shelf, they're made with the special brand of advanced technology, process controls, device characterization and circuit performance you expect from RCA. Inventors of the workhorse 2N3055.

Our special way

These transistors have multiple epitaxial base structure and 4-layer pi-nu construction, for high voltage and energy-handling capabilities. Rugged clip-lead connections for reliability and high current-handling. Plus a thermal cycling rating that helps you design for optimum reliability vs. cost. All of which makes these devices excellent choices for 20 kHz switching regulators and inverters, Motor switches, TV monitors, Hammer, solenoid and relay drivers. Electronic ignition.

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RCA. Powerhouse in Transistors.

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